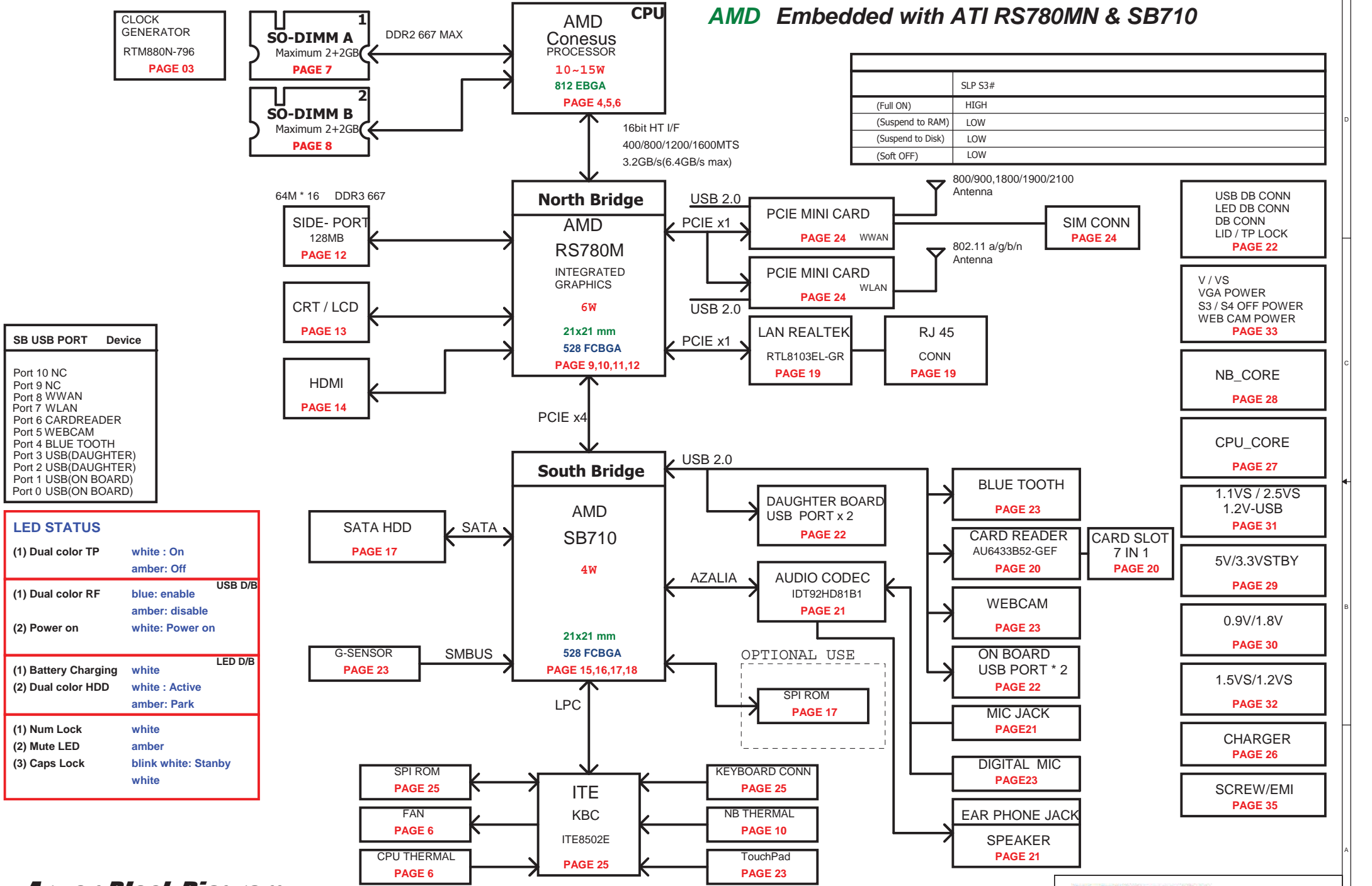


AMD Embedded with ATI RS780MN & SB710



SB USB PORT	Device
Port 10	NC
Port 9	NC
Port 8	WWAN
Port 7	WLAN
Port 6	CARDREADER
Port 5	WEBCAM
Port 4	BLUE TOOTH
Port 3	USB(DAUGHTER)
Port 2	USB(DAUGHTER)
Port 1	USB(ON BOARD)
Port 0	USB(ON BOARD)

LED STATUS	
(1) Dual color TP	white : On amber: Off
(1) Dual color RF	blue: enable amber: disable
(2) Power on	white: Power on
LED D/B	
(1) Battery Charging	white
(2) Dual color HDD	white : Active amber: Park
LED D/B	
(1) Num Lock	white
(2) Mute LED	amber
(3) Caps Lock	blink white: Stanby white




Arwen Block Diagram
H310UA1

Table of Contents

PAGE	DESCRIPTION
1	Block Diagram
2	INDEX & POWER STATUS
3	CLOCK GEN
4-8	CPU
9-12	North bridge RS780
13	CONN - LVDS/CRT
14	CONN - HDMI
15-18	SOUTH BRIDGE RS780
19	LAN - RT8103EL
20	CARD READER - ALCOR AU6433B52-GEF
21	AUDIO - IDT 92HD81
22	USB CONN / SWITCH / LID
23	BT / WEBCAM / TOUCHPAD / G-SENSOR
24	WLAN / WWAN
25	KBC - ITE8502E
26	PWR - BATTERY CHARGER
27	PWR - CPU CORE
28	PWR - NB CORE
29	PWR 5V / 3.3 VSTBY
30	PWR 1.8V / 0.9V
31	PWR - 1.1VS / 2.5VS / 1.2V-USB
32	PWR - 1.5VS / 1.2VS
33	PWR - V / VS / VGA POWER
34	POWER SEQUENCE
35	OTHER SCREW / EMI CAPS

Power States

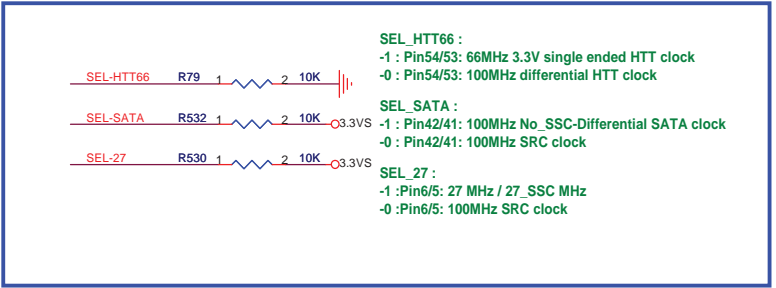
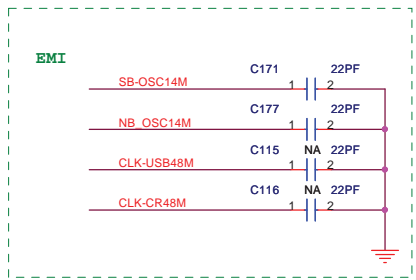
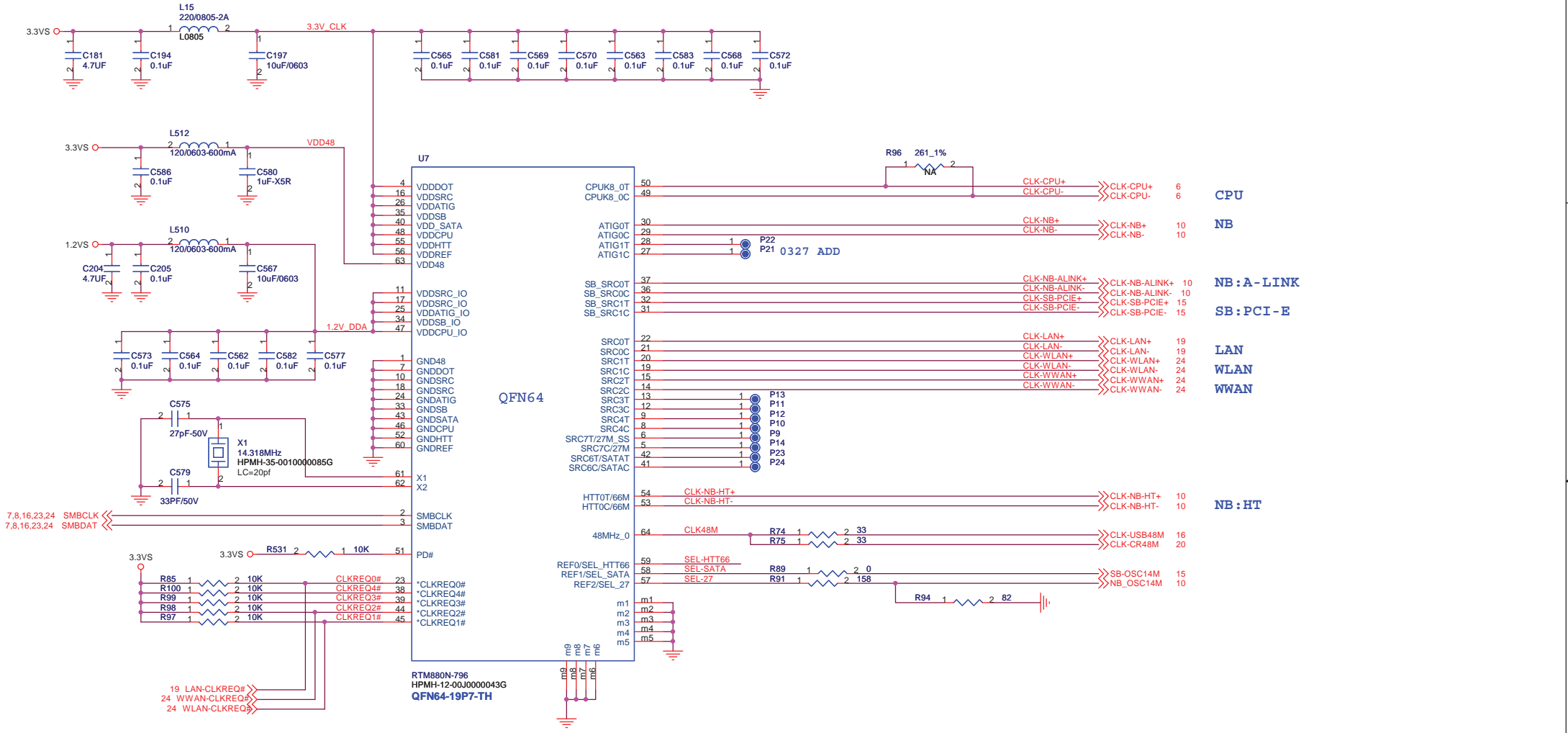
POWER PLANE	VOLTAGE	PAGE	DESCRIPTION	CONTROL SIGNAL	ACTIVE IN
ACIN	~+19V	26	ADAPTER IN POWER		S0-S5
B+	+10~+19V	13,23,24,26,27,28,29,30,31,32,33	MAIN POWER		S0-S5
VBAT	+3.0V~+3.3V	15	RTC BATTERY		S0-S5
LDO5	+5V	22,29	LDO POWER	B+	S0-S5
LDO3	+3.3V	29	LDO POWER	B+	S0-S5
3.3VSTBY	+3.3V	15,16,17,22,25,26,29,31,33	STANDBY POWER	B+	S0-S5
3.3V-DUAL	+3.3V	15,16,17,18,25,31,33	EC CTRLD POWER	3.3VDUAL-ON#	BY EC CONTROL
1.2V-DUAL	+1.2V	18,31	3.3V-DUAL CTRLD POWER	3.3V-DUAL	BY EC CONTROL
5V	+5V	22,23,29,30,32,33,	SUS-C# CTRLD POWER	SUSC#	S0,S3
3.3V	+3.3V	13,33	SUS-C# CTRLD POWER	SUSC	S0,S3
1.8V	+1.8V	04,05,06,07,08,30,33	SUS-C# CTRLD POWER	SUSC#	S0,S3
0.9V	+0.9V	04,05,07,08,30	SUS-C# CTRLD POWER	SUSC#,SUSB#	S0,S3
5VS	+5V	06,13,14,17,18,21,22,23,25,27,28,31,32,33	SUS-B# CTRLD POWER	SUSB	S0
3.8VS	+3.8V	23,33	SUS-B# CTRLD POWER	SUSB#	S0
3.3VS	+3.3V	03,06,07,08,10,11,12,13,14,16,17,18,20,21,22,23,24,25,27,28,29,31,32,33	SUS-B# CTRLD POWER	SUSB	S0
2.5VS	+2.5V	06,31	SUS-B# CTRLD POWER	SUSB#	S0
1.8VS	+1.8V	06,10,11,12,15,16,33	SUS-B# CTRLD POWER	SUSB	S0
1.5VS	+1.5V	11,12,16,24,28,31,32	SUS-B# CTRLD POWER	SUSB#	S0
1.2VS	+1.2V	04,06,11,15,17,18,32	SUS-B# CTRLD POWER	SUSB#	S0
1.1VS	+1.1V	09,10,11,12,31	SUS-B# CTRLD POWER	SUSB#	S0
CPU_CORE		04,27	CPU CORE POWER	SUSB#	S0
NB_CORE	+1.0V~+1.1V	11,18,32	NORTH BRIDGE CORE POWER	1.1VS-PG	S0
BATA+	+10V~+17V	26	MAIN BATTERY		S0-S5

GND PLANE	PAGE	DESCRIPTION
 GND	ALL	
 AGND	19	
 LAN-GND	21	

FLEX Computing

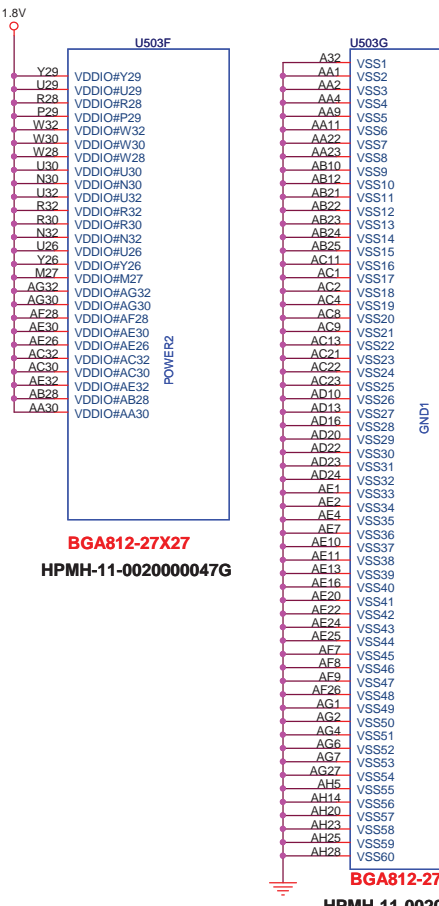
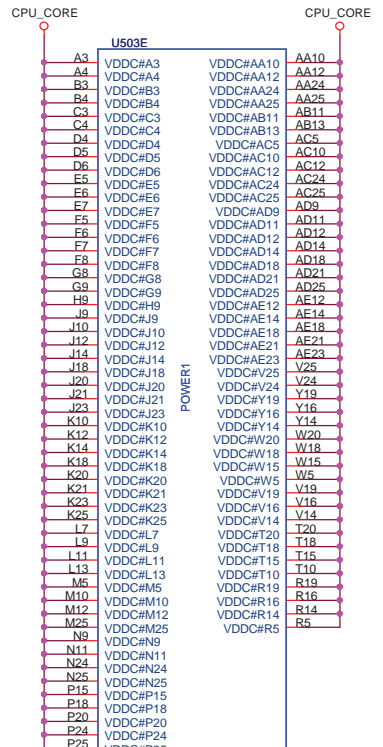
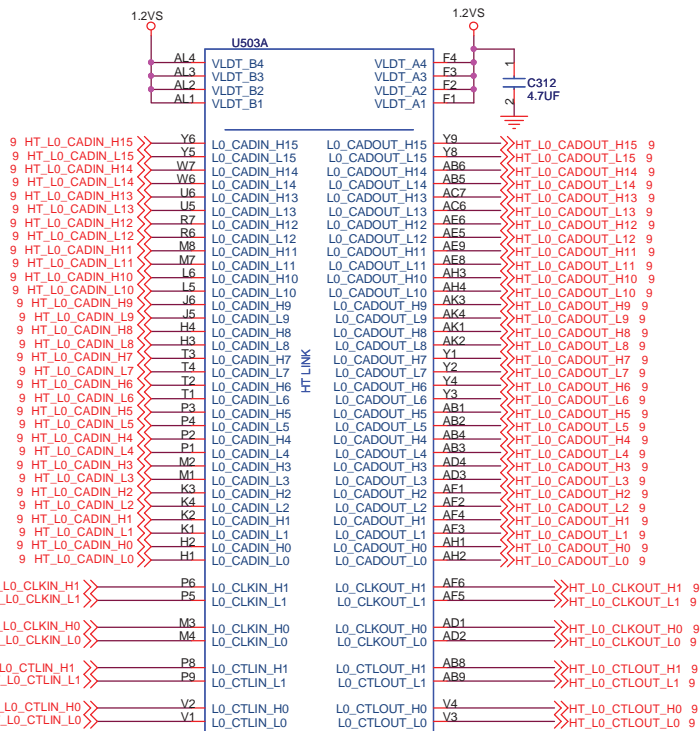
Project Name : ARWEN UA1	Title : Power Diagram
Size : Custom	Document Number : HPMH-40GAB4000-D000
Date: Monday, August 17, 2009	Rev : D
Sheet : 2	of 35

CLOCK GENERATOR



CPU HT/PWR/GND

VLDT Trace at Itast 200 mils wide

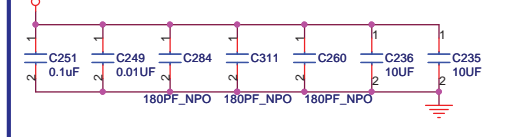
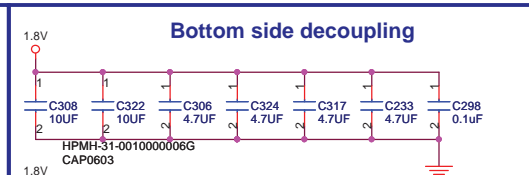
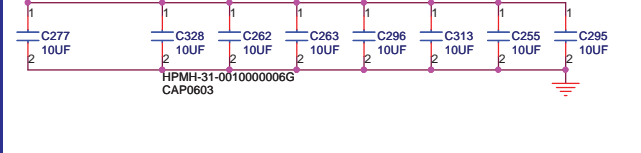
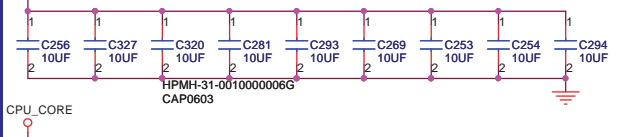
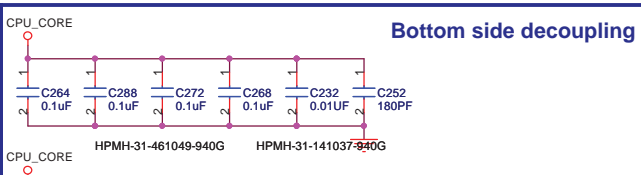
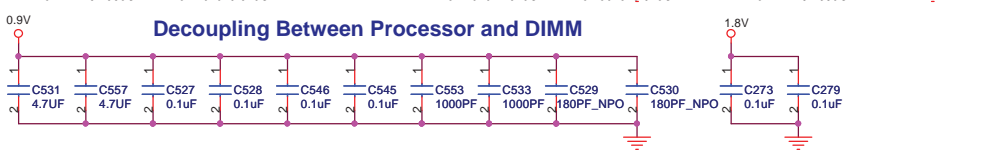
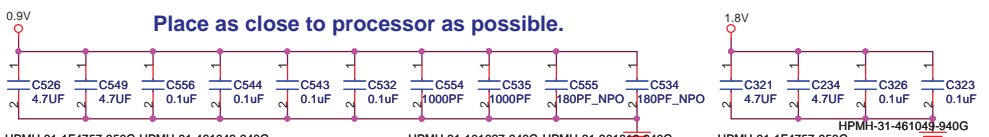
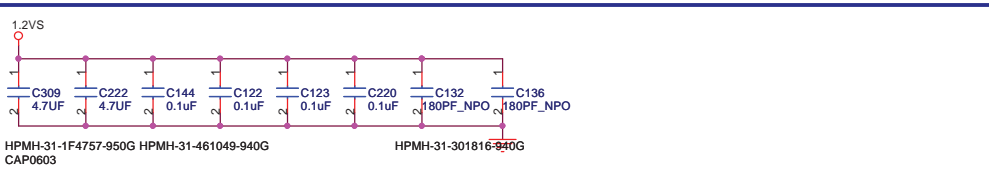


BGA812-27X27
HPMH-11-0020000047G

BGA812-27X27
HPMH-11-0020000047G

BGA812-27X27
HPMH-11-0020000047G

BGA812-27X27
HPMH-11-0020000047G

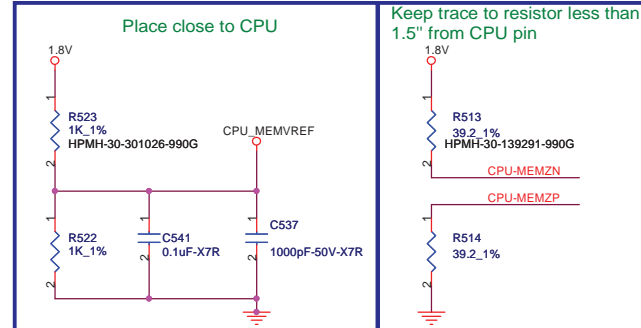
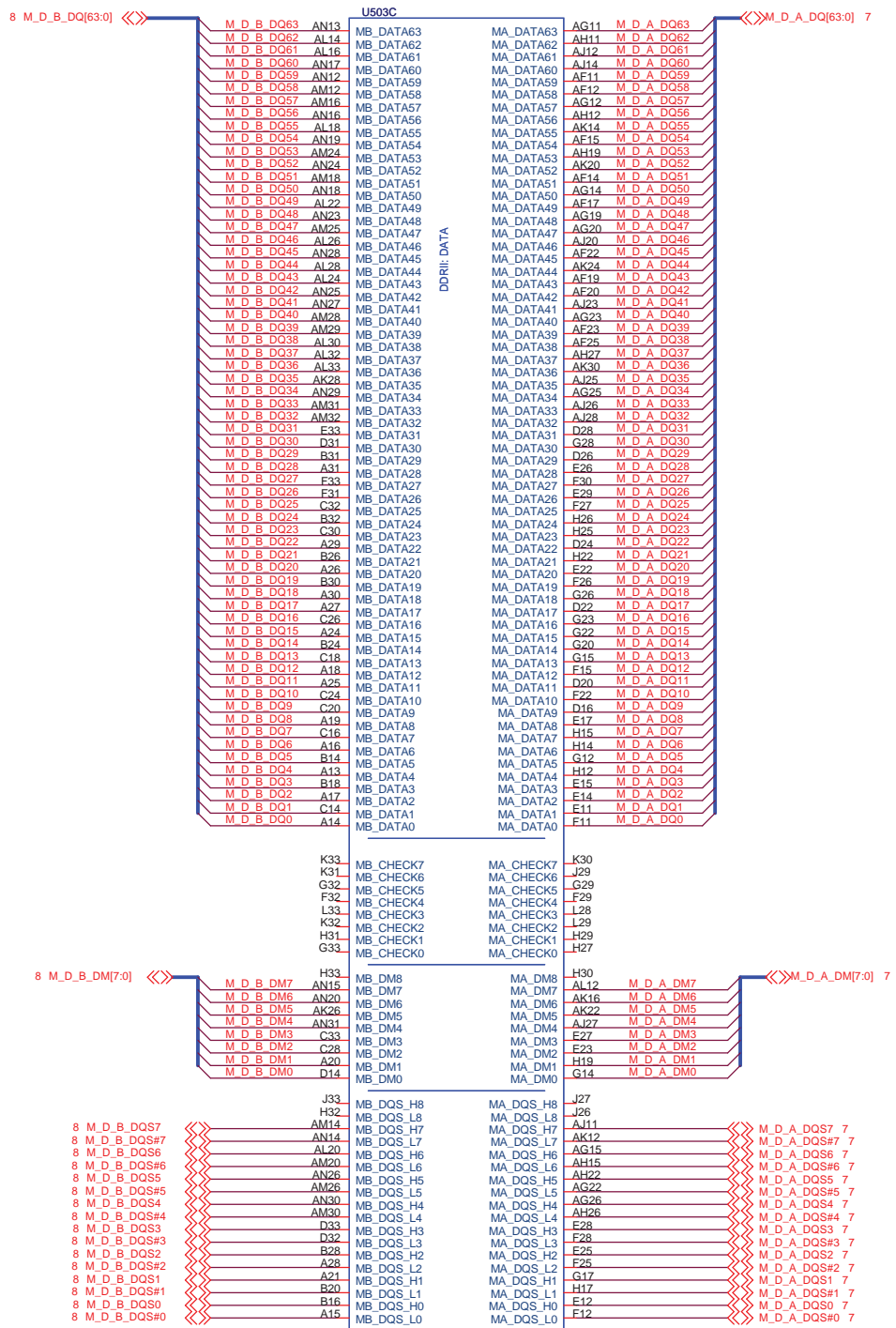


FLEX Computing

Project Name : ARWEN UA1		Title : CPU HT/PWR/GND	
Size : A3	Document Number : HPMH-40GAB4000-D000	Rev : D	
Date : Monday, August 17, 2009	Sheet : 4	of 35	

CPU MEMORY A/B

CPU Memory Interface



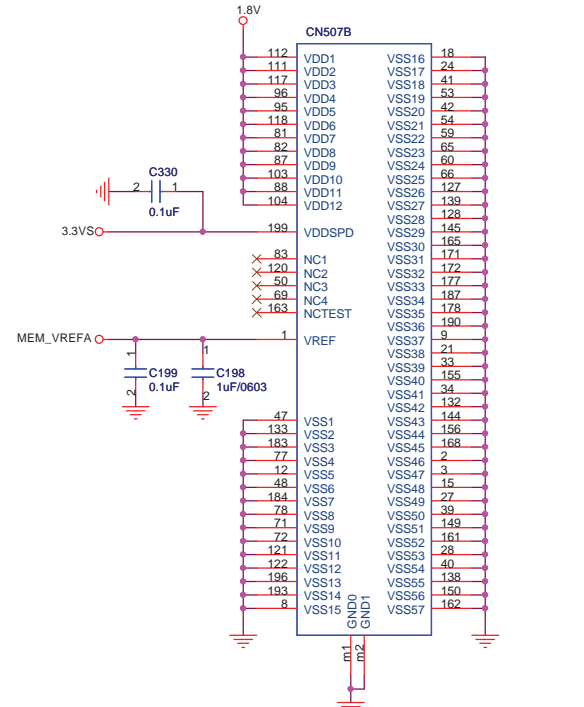
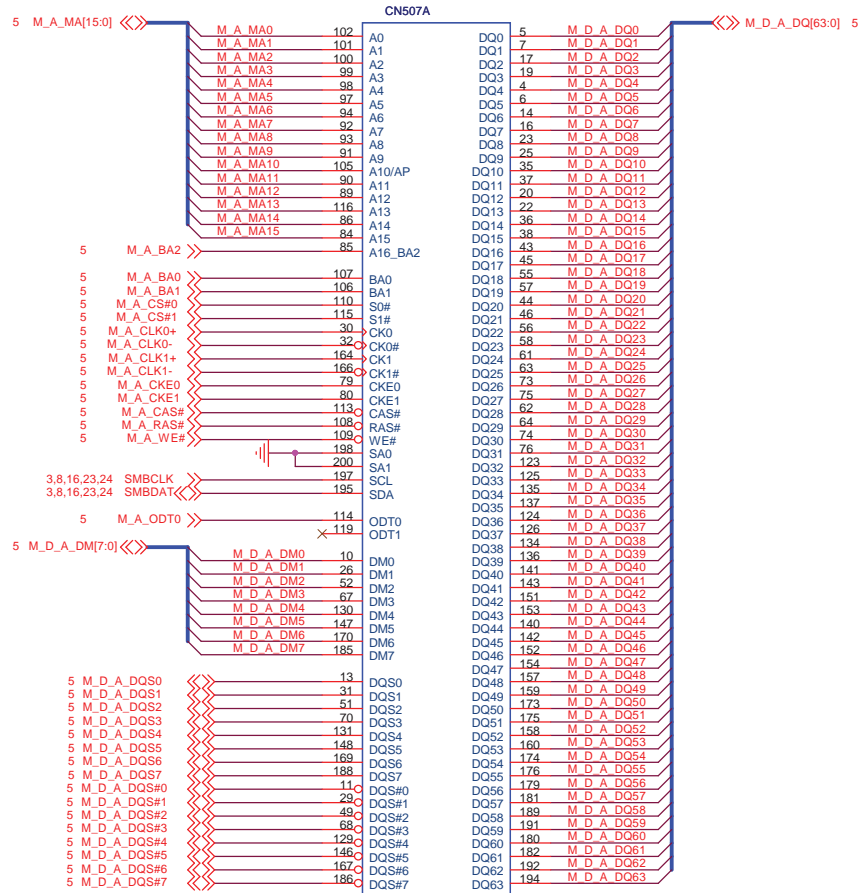
FLEX Computing

Project Name: ARWEN UA1 | Title: CPU Memory Interface

Size: A3 | Document Number: HPMH-40GAB4000-D000 | Rev: D

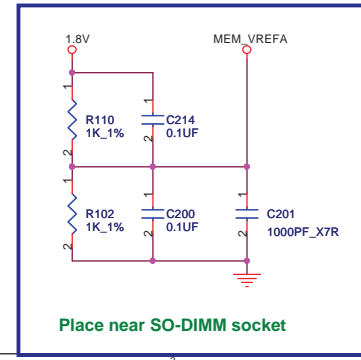
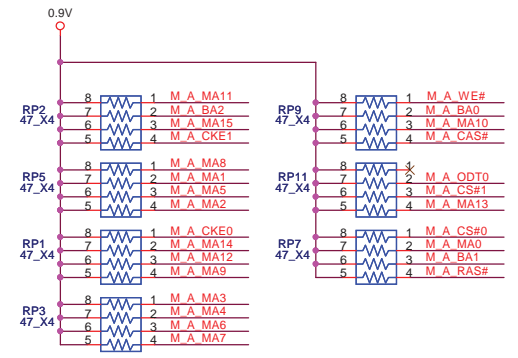
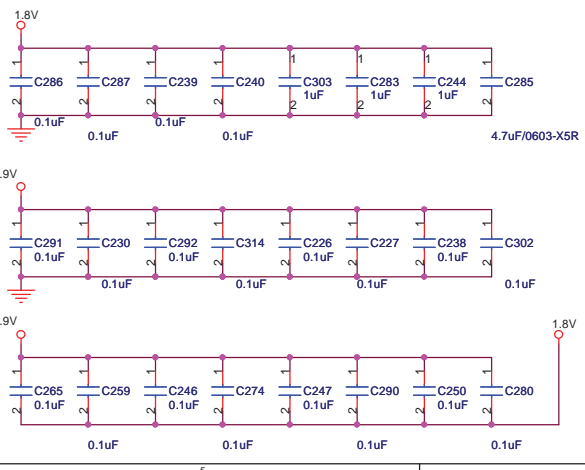
Date: Monday, August 17, 2009 | Sheet: 5 of 35

Memory Channel A



AS0A421-N4RN-7F
 HPMH-39-034000033G
 CONN DDR2 200P H:4.0mm AS0A421-N4RN-7F
 DDR-200P-4H

Layout :
 Place these Caps near So-DimmA



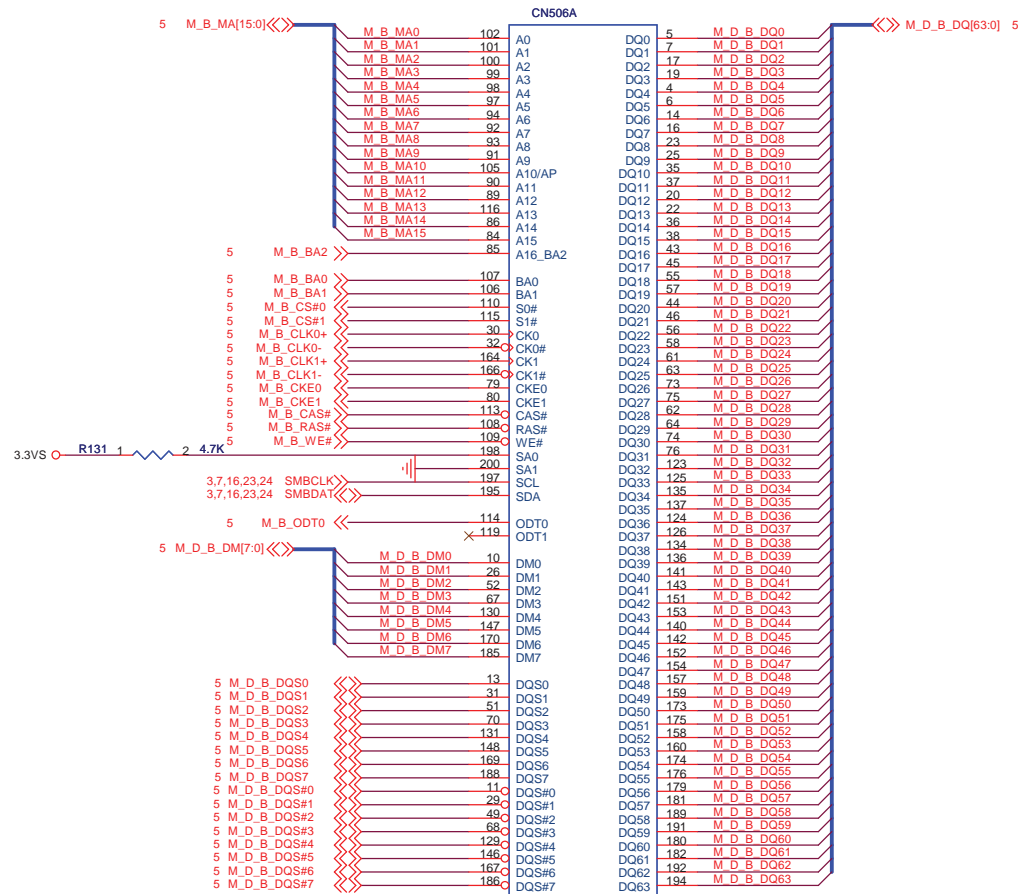
Place close to CPU within 1.5"

FLEX Computing

Project Name: ARWEN UA1		Title: DDR2 SO-DIMM A / Termination	
Size: A3	Document Number: HPMH-40GAB4000-D000	Rev: D	
Date: Monday, August 17, 2009	Sheet: 7		of 35

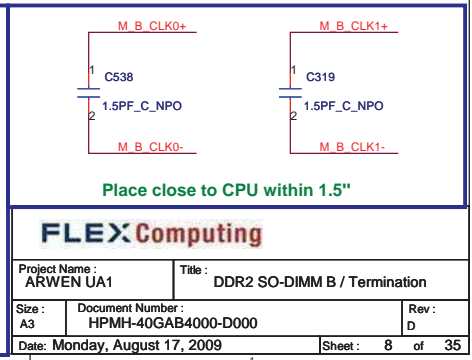
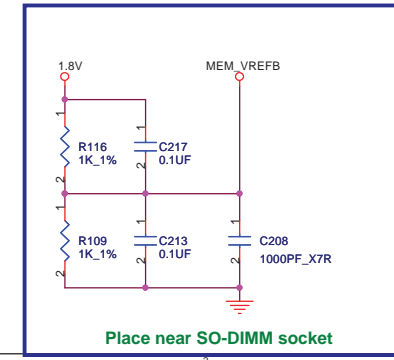
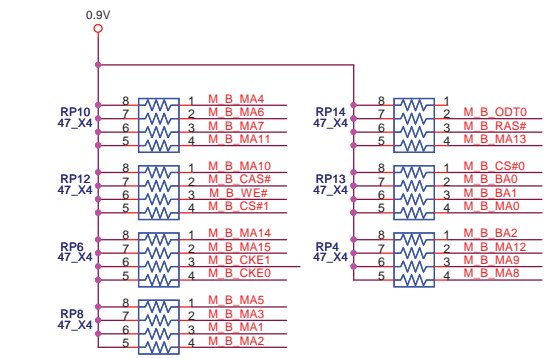
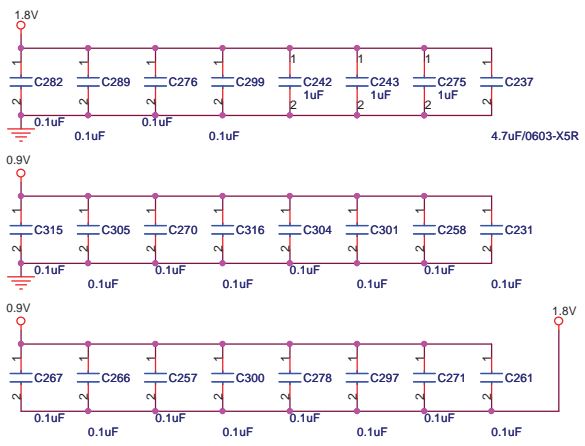
Memory Channel B

DDR2 Termination DDR2 SO-DIMMB



80044-1821
HPMH-39-0340000034G
CONN DDR2 200P H:4mm 80044-1821
DDR-200P-4H-1

Layout :
Place these Caps near So-DimmA



FLEX Computing

Project Name: ARWEN UA1 Title: DDR2 SO-DIMM B / Termination

Size: A3 Document Number: HPMH-40GAB4000-D000 Rev: D

Date: Monday, August 17, 2009 Sheet: 8 of 35

RS780M HT/PCIE/HDMI

U504A

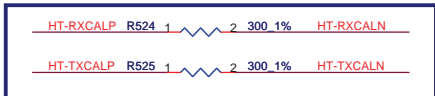
PART 1 OF 6

HYPER TRANSPORT CPU I/F



RS780MN
HPMH-10-0010000050G
FCBGA528-RS780M

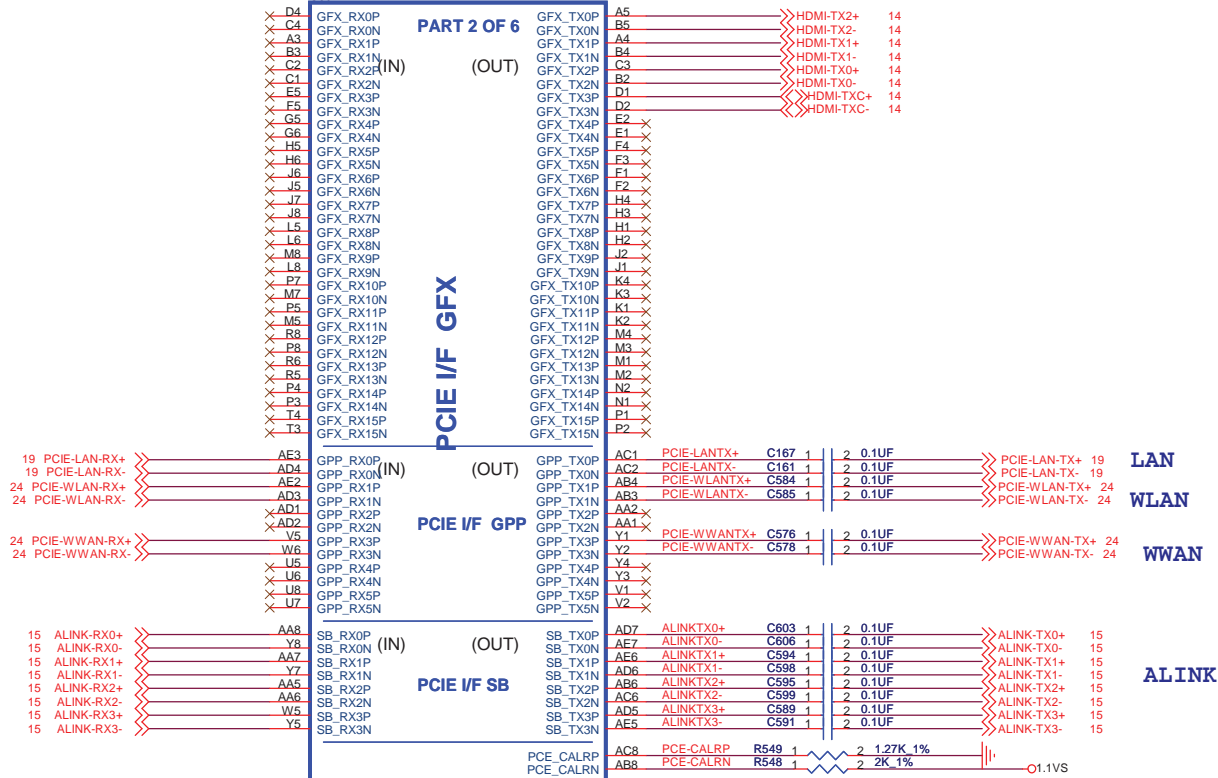
301 ohm to 300 ohm



U504B

PART 2 OF 6

PCIE I/F GFX



RS780MN
HPMH-10-0010000050G
FCBGA528-RS780M

UMA HDMI

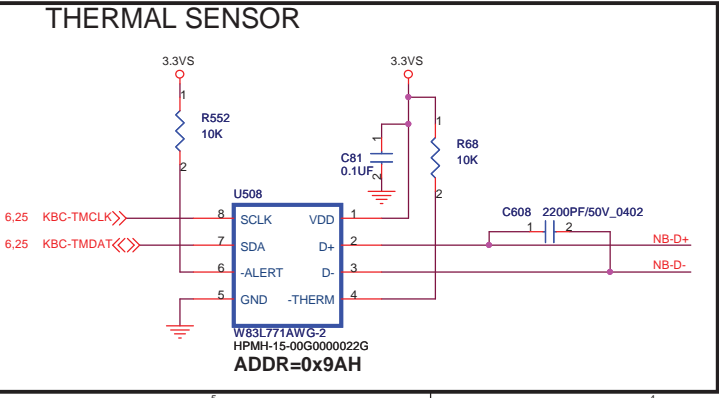
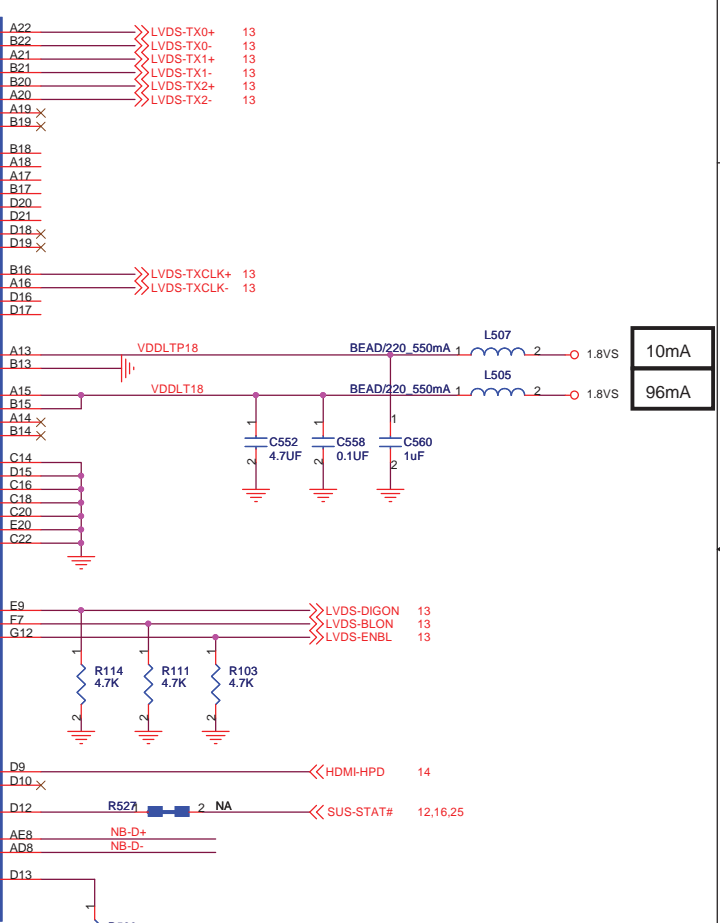
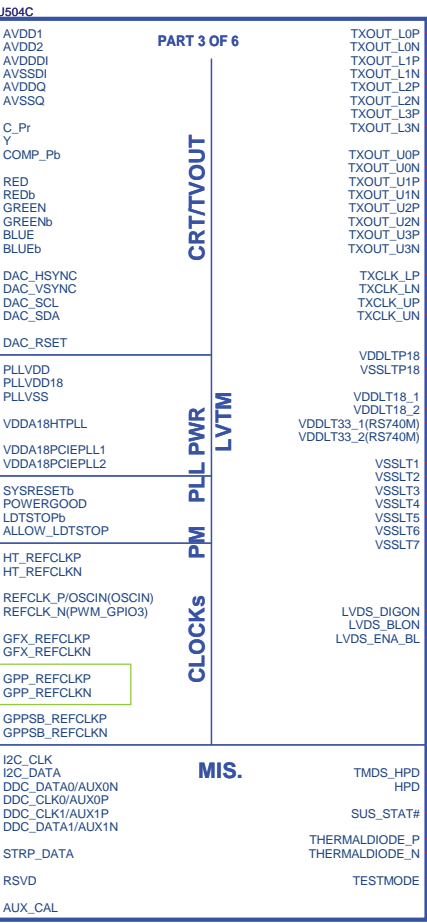
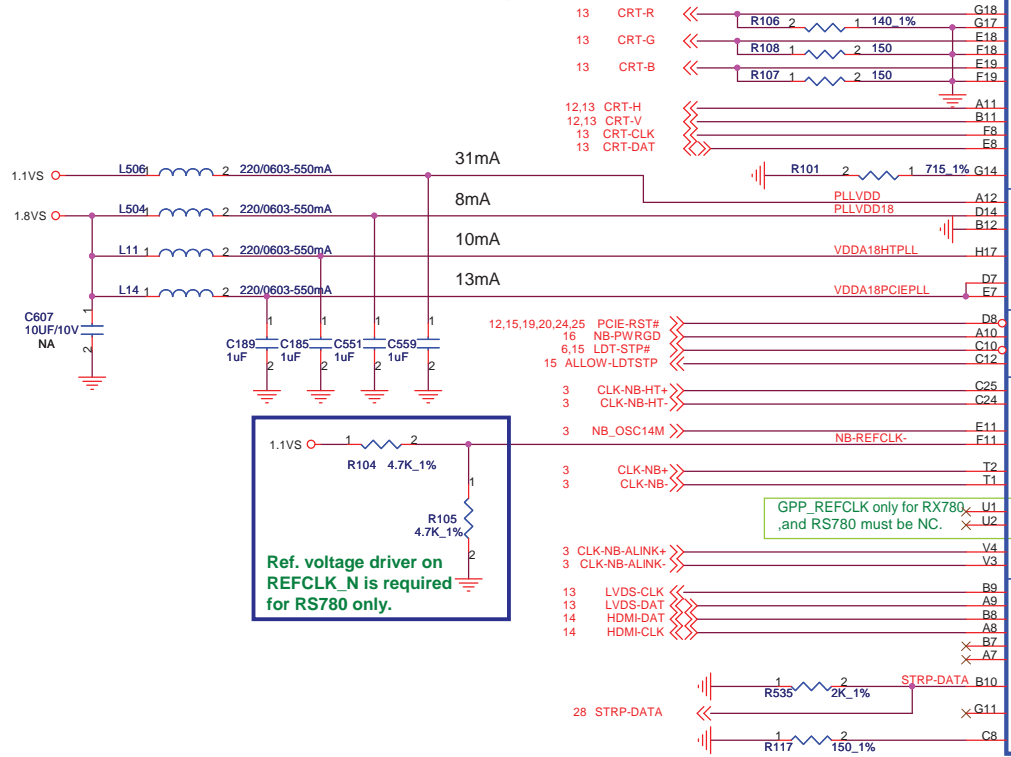
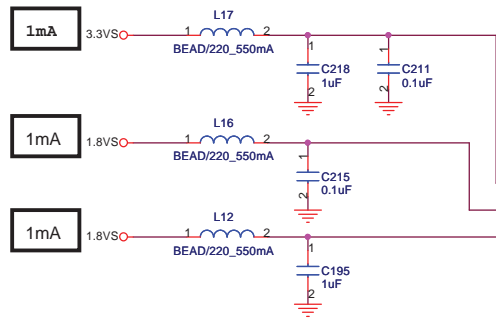
FLEX Computing

Project Name: ARWEN UA1 | Title: RS780M HT/PCIE/HDMI Interface

Size: A3 | Document Number: HPMH-40GAB4000-D000 | Rev: D

Date: Monday, August 17, 2009 | Sheet: 9 of 35

RS780M HT/PCIE/HDMI



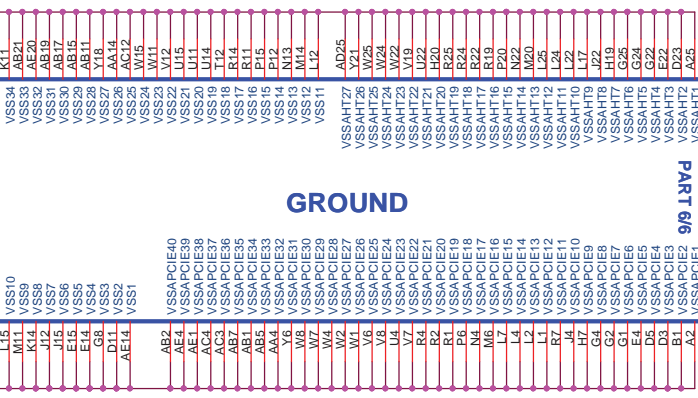
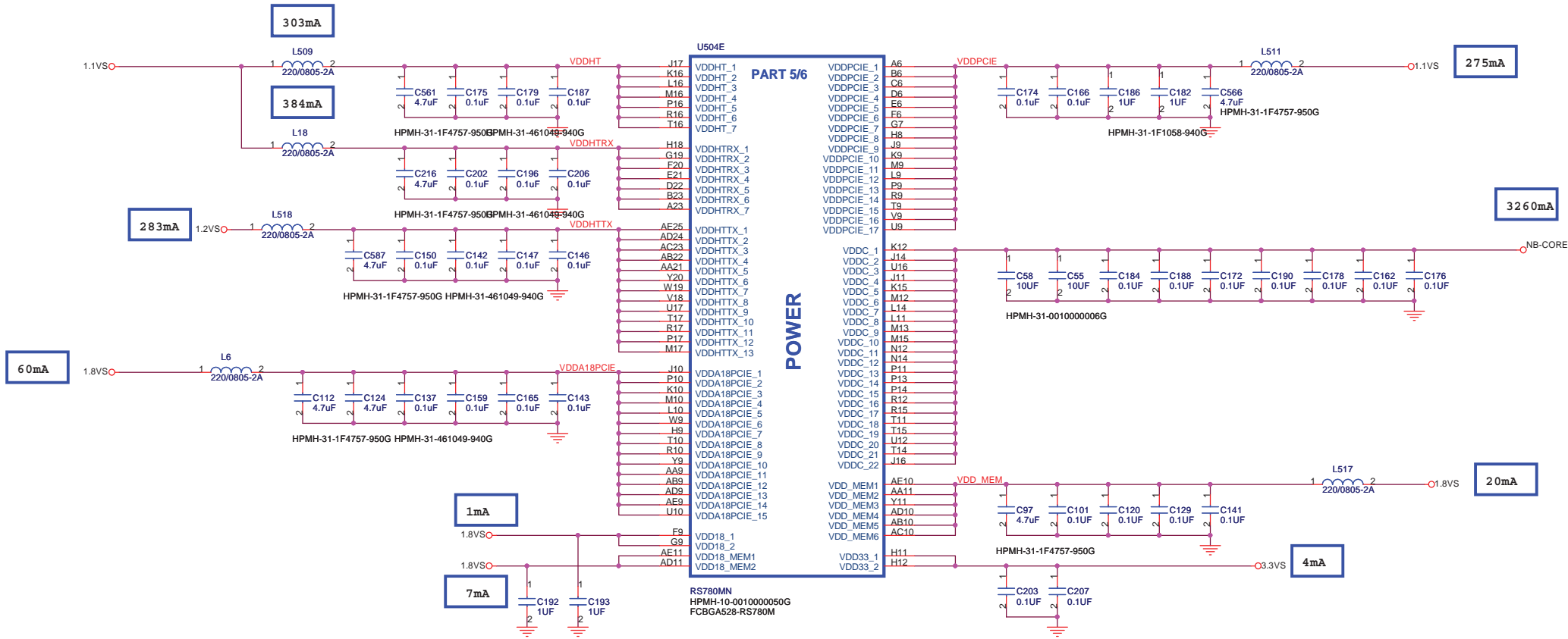
FLEX Computing

Project Name: ARWEN UA1 | Title: RS780M Video Interface

Size: A3 | Document Number: HPMH-40GAB4000-D000 | Rev: D

Date: Monday, August 17, 2009 | Sheet: 10 of 35

RS780M Power/Ground



U504F
RS780MN
FCBGA528-RS780M
HPMH-10-0010000050G

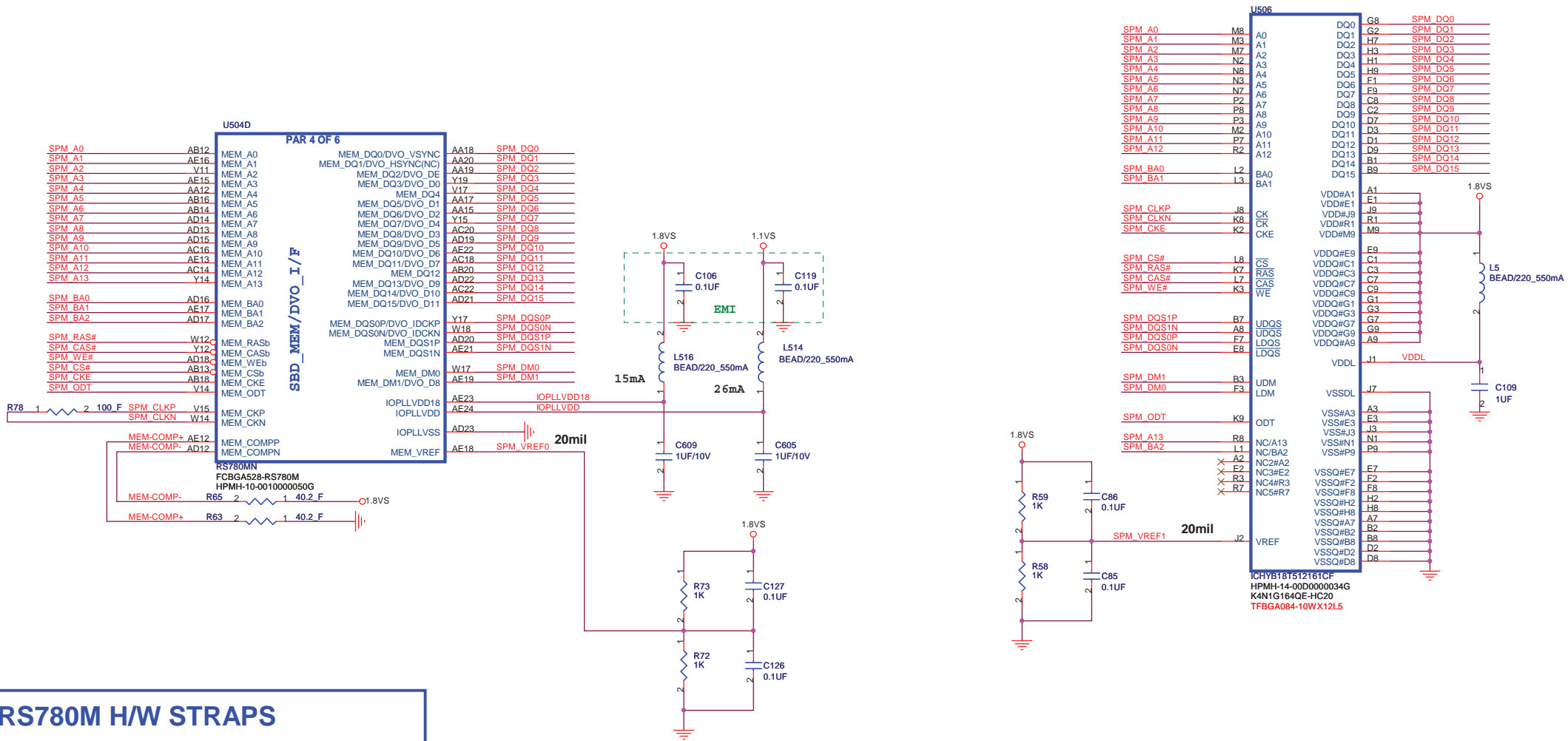
GROUND

PART 5/6

POWER

PART 6/6

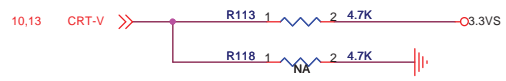
NB_SIDE PORT / STRAPS



RS780M H/W STRAPS

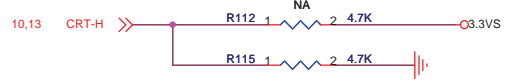
STRAP_DEBUG_BUS_GPIO_ENABLE

Enables the Test Debug Bus using GPIO.
 DAC_VSYNC (RS780.Pin B11)
 1 : Disable (RS780) (default)
 0 : Enable (RS780)



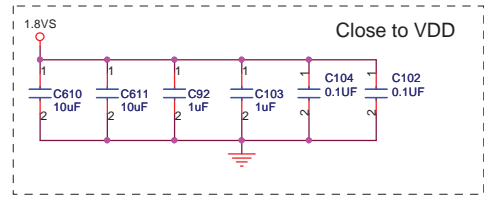
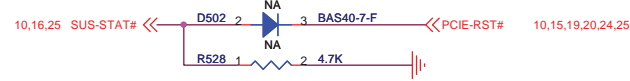
RS780: Enable Side Port Memory

Selects if Memory SIDE PORT is available or not
 DAC_HSYNC (RS780.Pin A11)
 1 : Disable (default)
 0 : Enable
 Register Readback of strap:
 NB_CLKCFG:CLK_TOP_SPARE_D[1]



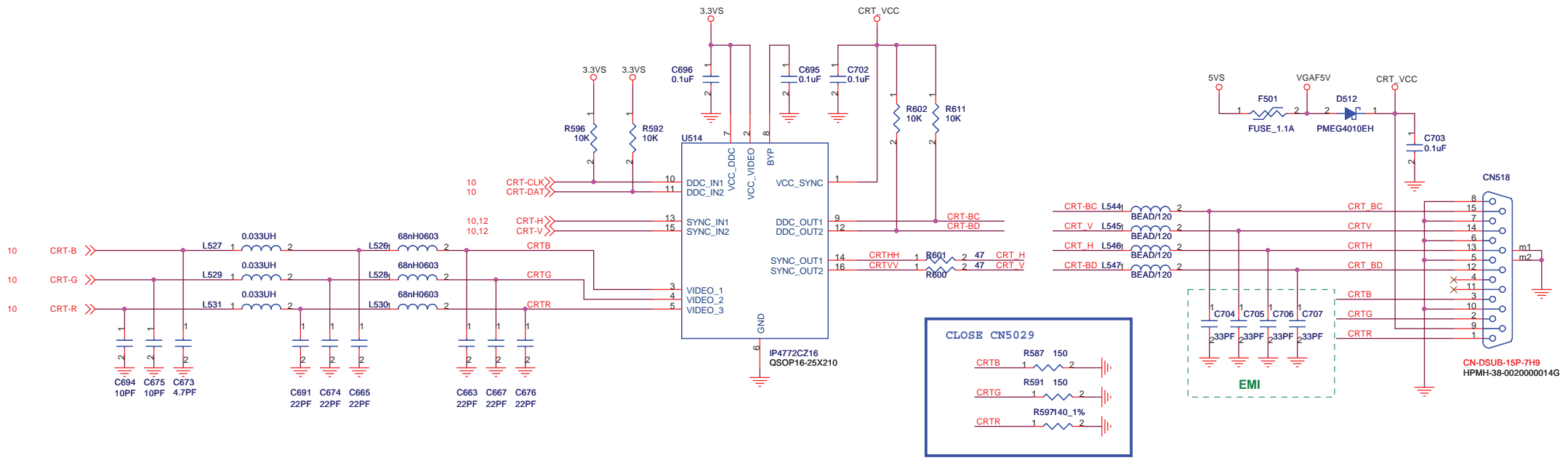
DFT_GPIO1: LOAD_EEPROM_STRAPS

Selects Loading of STRAPS from EPROM
 SUS_STAT# (RS780.Pin D12)
 -1*: Bypass the loading of EEPROM straps and use Hardware Default Values
 -0 : I2C Master can load strap values from EEPROM if connected, or use default values if not connected

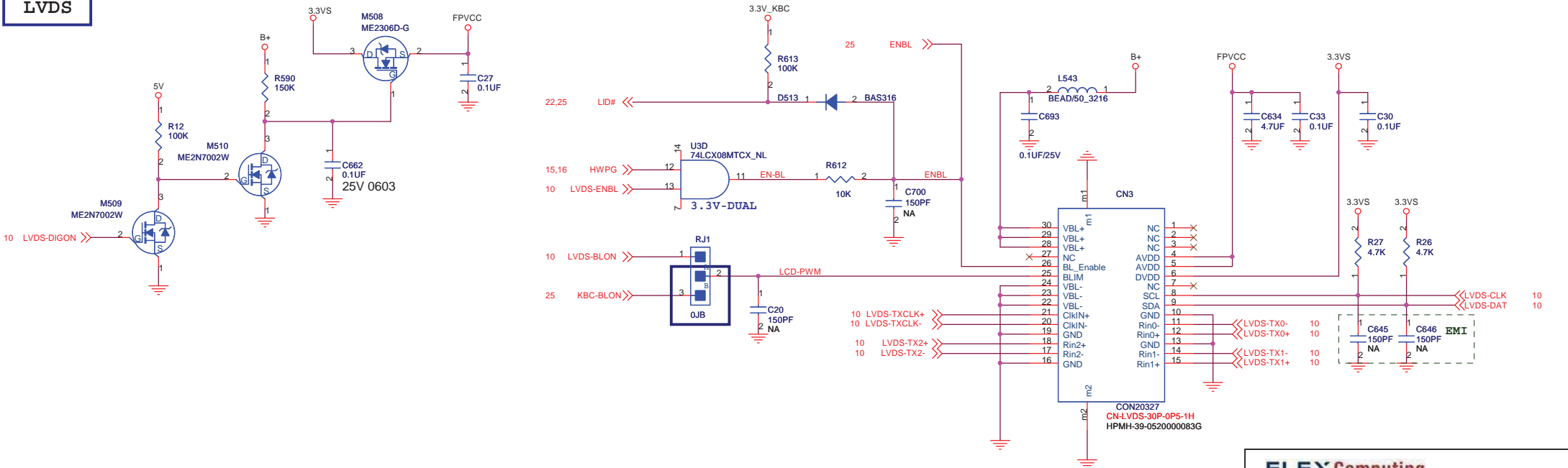


FLEX Computing	
Project Name : ARWEN UA1	Title : RS780M SBD / STRAPS
Size : A3	Document Number : HPMH-40GAB4000-D000
Date: Monday, August 17, 2009	Rev : D
Sheet : 12 of 35	

CRT



LVDS



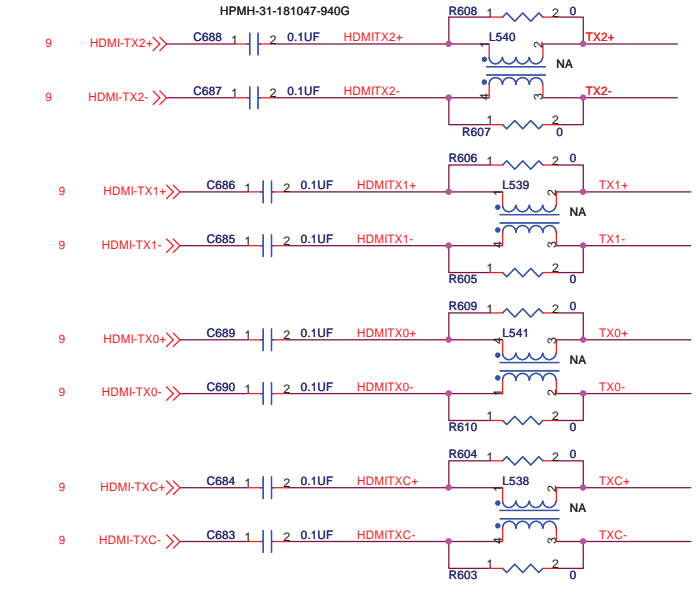
FLEX Computing

Project Name : ARWEN UA1		Title : LVDS / CRT Connector
Size : A3	Document Number : HPMH-40GAB4000-D000	Rev : D
Date : Monday, August 17, 2009	Sheet : 13 of 35	

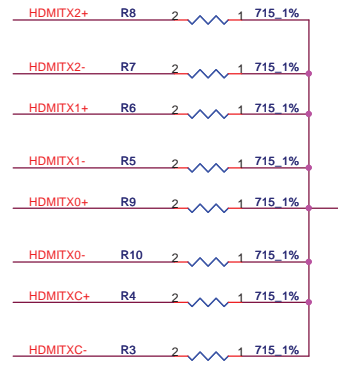
HDMI

CLOSE CN5031

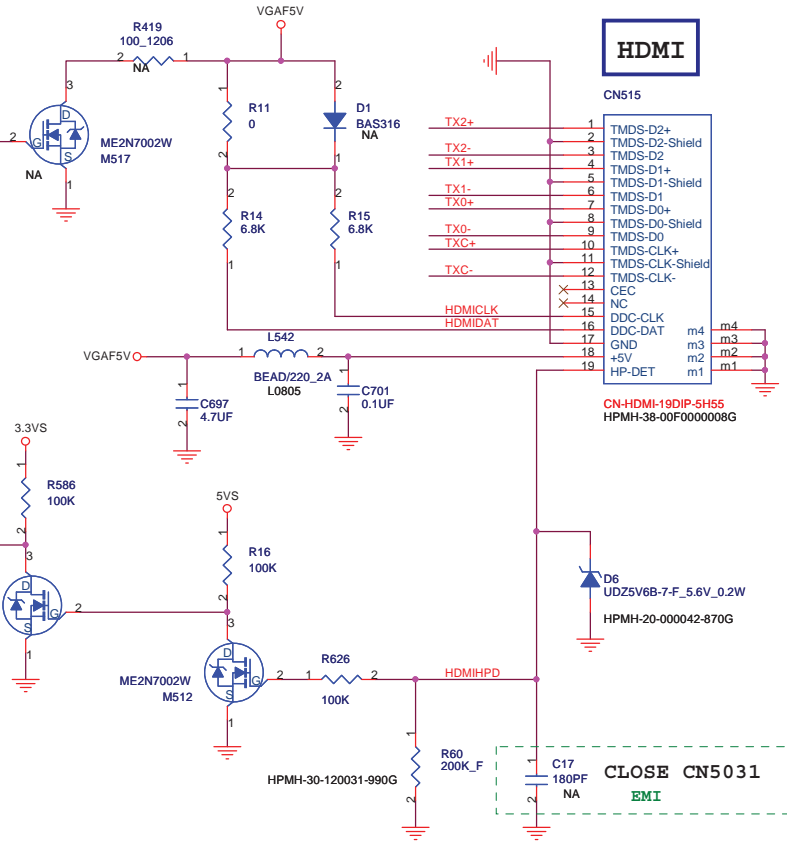
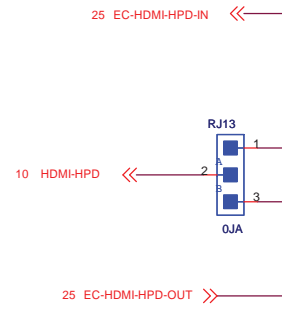
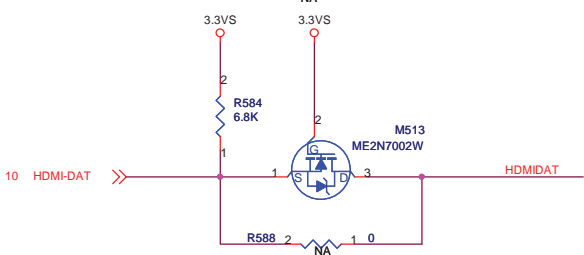
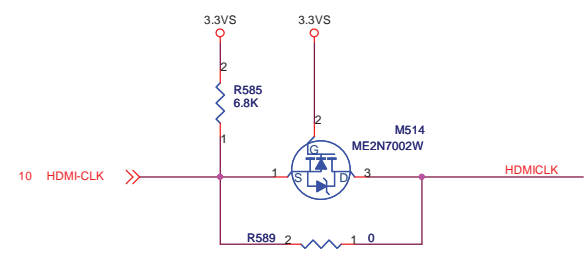
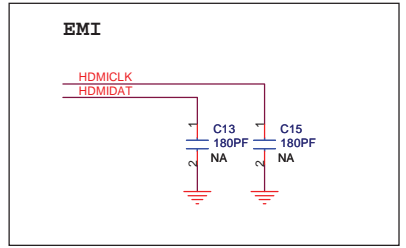
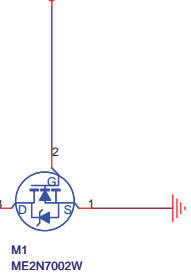
HPMH-32-4000000104G



M92 SPEC SET 499 ohm

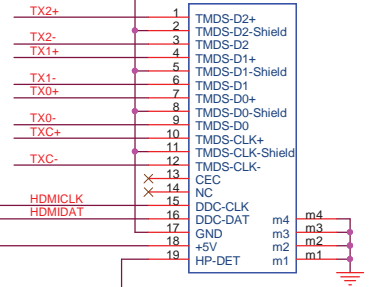


5VS



HDMI

CN515



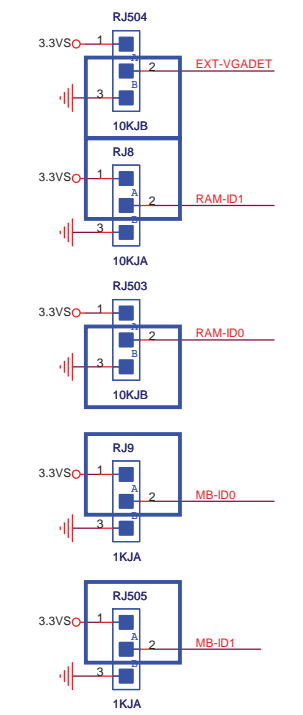
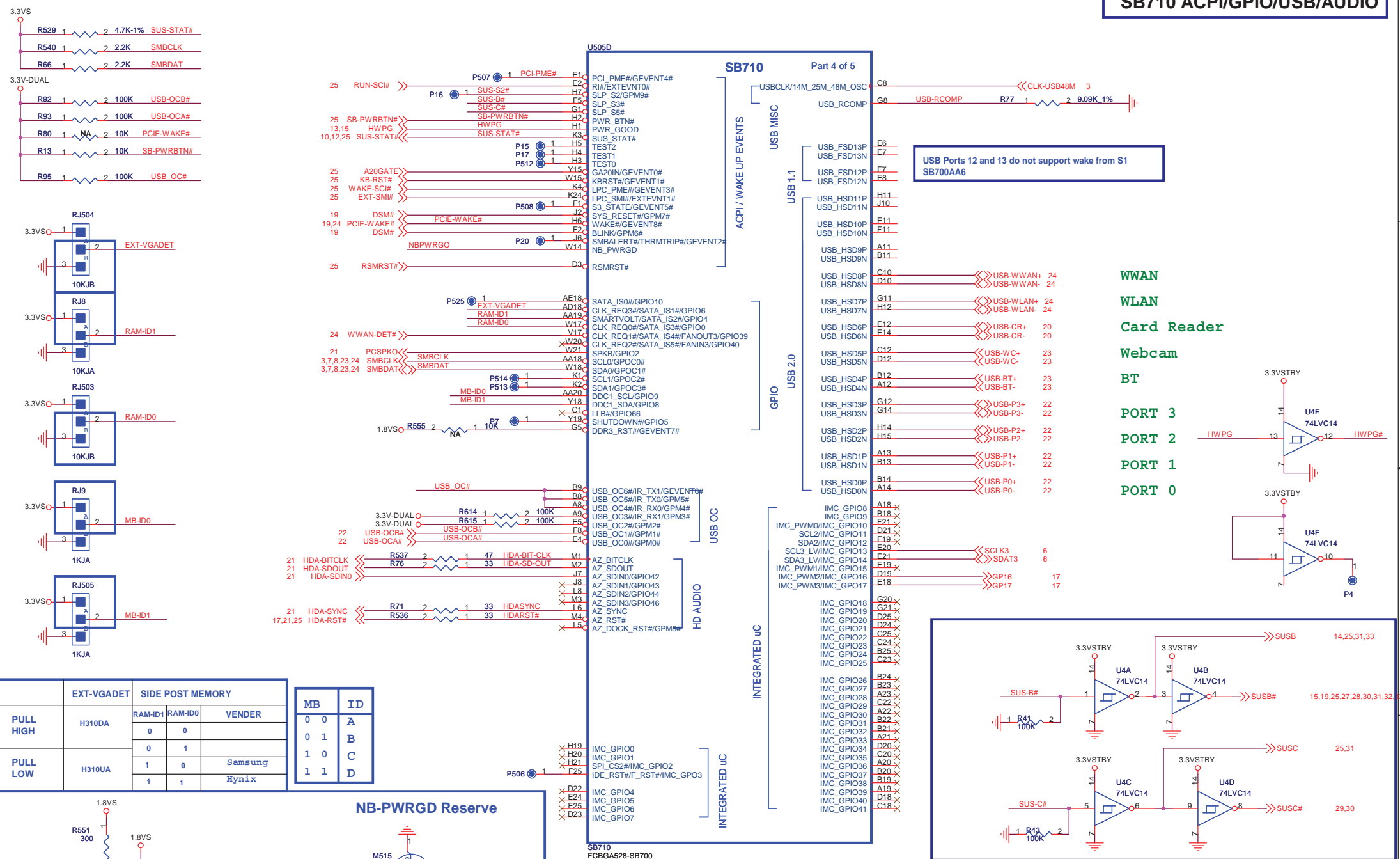
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HPMH-38-00F000008G

CLOSE CN5031
EMI

FLEX Computing

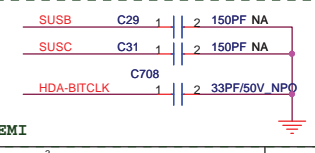
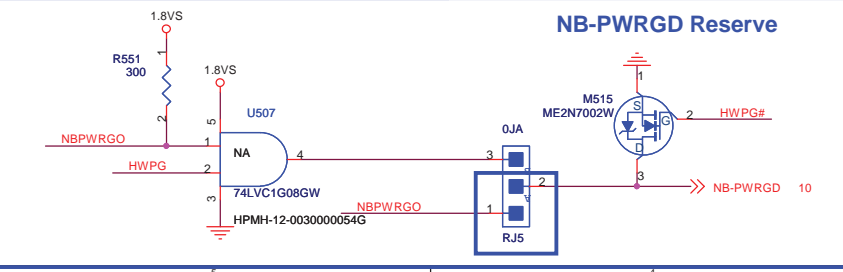
Project Name : ARWEN UA1		Title : HDMI Connector	
Size : A3	Document Number : HPMH-40GAB4000-D000	Rev : D	
Date : Monday, August 17, 2009		Sheet : 14	of 35

SB710 ACPI/GPIO/USB/AUDIO



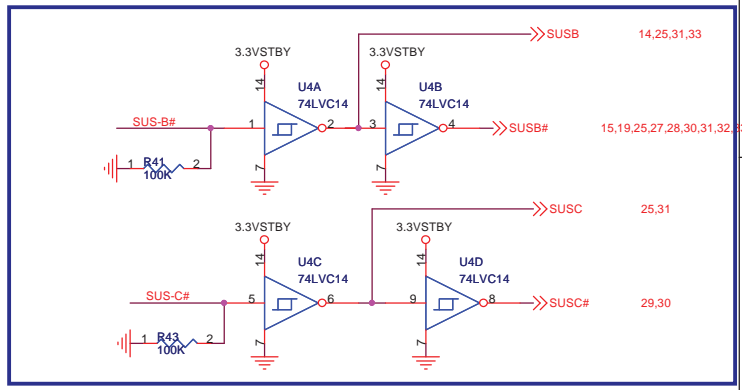
	EXT-VGADET	SIDE POST MEMORY		
		RAM-ID1	RAM-ID0	VENDER
PULL HIGH	H310DA	0	0	
PULL LOW	H310UA	0	1	Samsung
		1	1	Hynix

MB	ID
0	A
0	B
1	C
1	D



USB Ports 12 and 13 do not support wake from S1 SB700AA6

- WWAN
- WLAN
- Card Reader
- Webcam
- BT
- PORT 3
- PORT 2
- PORT 1
- PORT 0



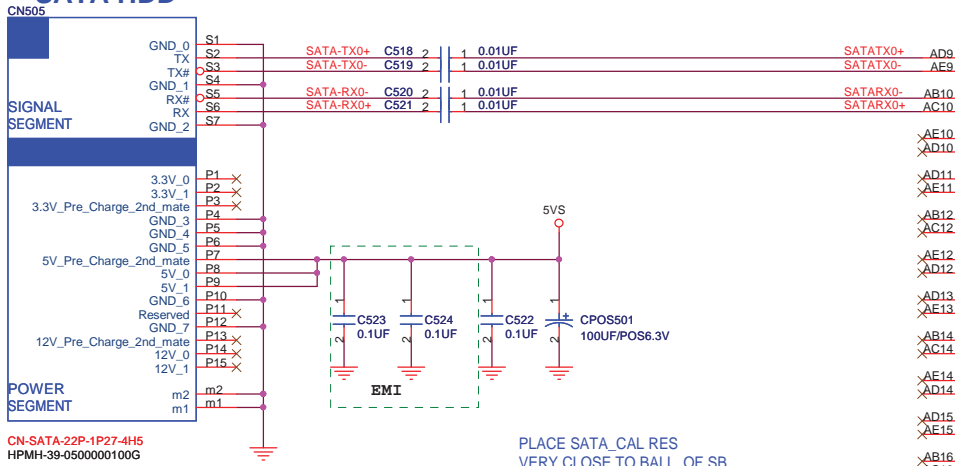
FLEX Computing

Project Name: ARWEN UA1 Title: SB710 ACPI/GPIO/USB/AUDIO

Size: A3 Document Number: HPMH-40GAB4000-D000 Rev: D

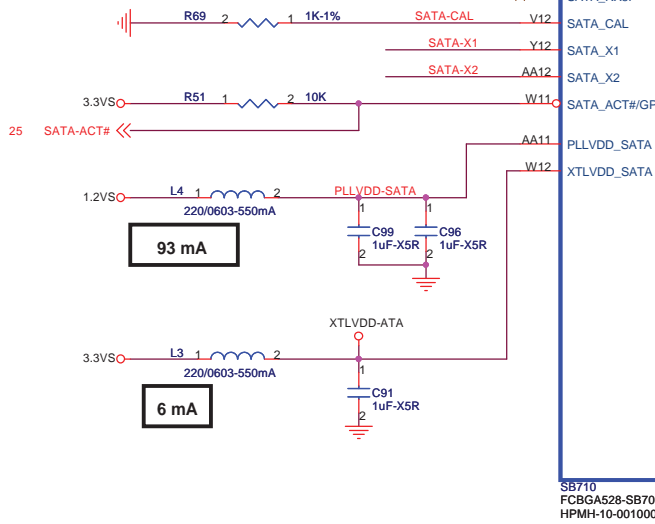
Date: Monday, August 17, 2009 Sheet: 16 of 35

SATA HDD

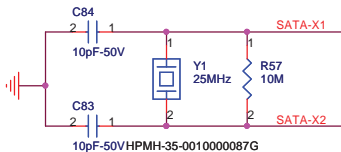


CN-SATA-22P-1P27-4H5
HPMH-39-050000100G

PLACE SATA_CAL RES
VERY CLOSE TO BALL OF SB

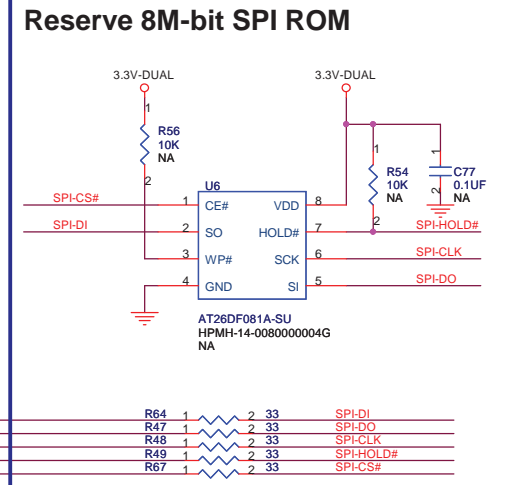
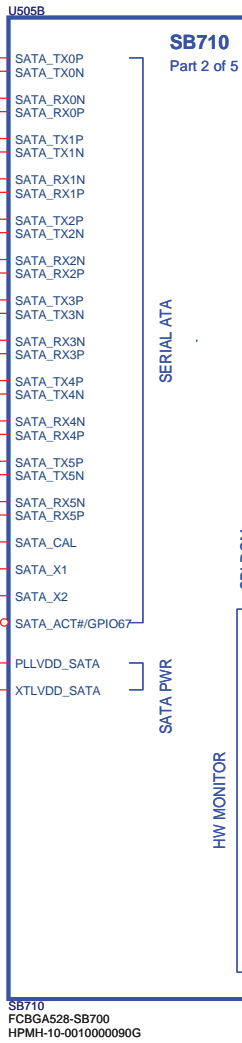


SATA 25MHz

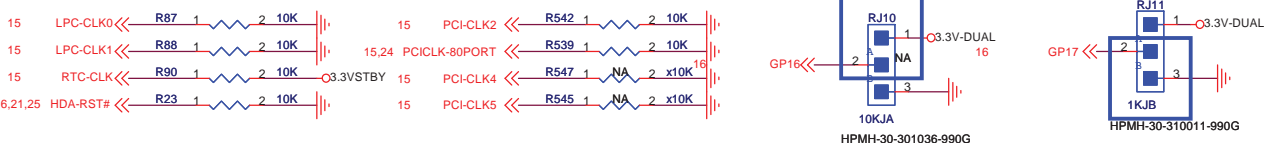


10pF-50VHPMH-35-0010000087G

SB710 SATA / IDE / HWM / SPI / STRAPS



SB710 H/W STRAPS



NOTE: SB700 HAS INTERNAL 15K PULL UP RESISTOR FOR RTC_CLK

	PCI-CLK2	PCI-CLK3	PCI-CLK4	PCI-CLK5	LPC-CLK0	LPC-CLK1	RTC-CLK	AZ-RST#	GP17	GP16
PULL HIGH	WATCHDOG TIMER ON NB_PWRGD ENABLED	USE DEBUG STRAPS	RESERVED	RESERVED	ENABLE PCI MEM BOOT (A11) IMC ENABLED (A12)	CLKGEN ENABLED	INTERNAL RTC DEFAULT	IMC ENABLED (A11) ENABLE PCI MEM BOOT (A12)	H,H = Reserved H,L = SPI ROM (Default)	
PULL LOW	WATCHDOG TIMER ON NB_PWRGD DISABLED DEFAULT	IGNORE DEBUG STRAPS DEFAULT			DISABLE PCI MEM BOOT (A11) IMC DISABLED (A12) DEFAULT	CLKGEN DISABLED DEFAULT	EXT. RTC (PD on X1, apply 32KHz to RTC_CLK)	IMC DISABLED (A11) DISABLE PCI MEM BOOT (A12) DEFAULT	L,H = LPC ROM L,L = FWH ROM	

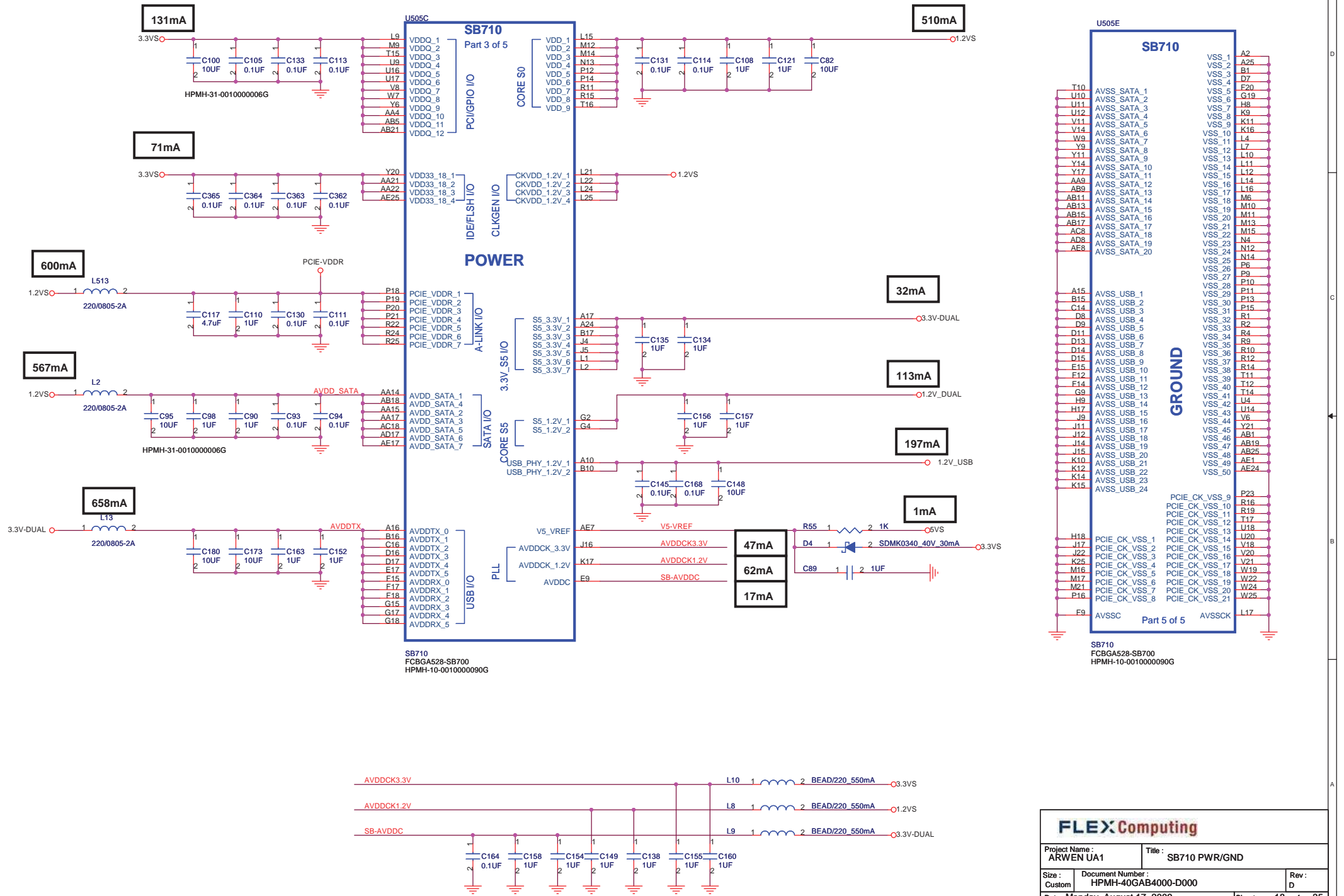
FLEX Computing

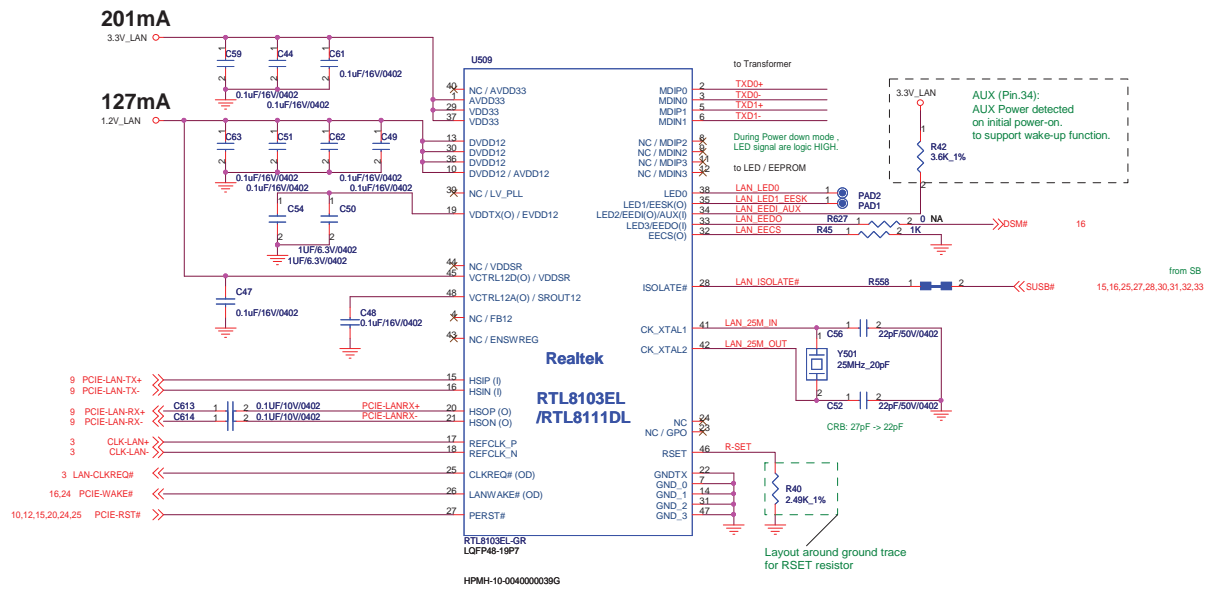
Project Name: ARWEN UA1 Title: SB710 SATA / IDE / SPI / HDD CONN

Size: A3 Document Number: HPMH-40GAB4000-D000 Rev: D

Date: Monday, August 17, 2009 Sheet: 17 of 35

SB710 PWR / GND





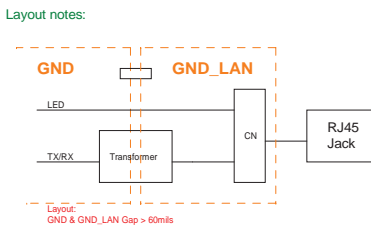
RTL8103E LED Configuration:

LED1-0	'00	01	10	11
LED0	Tx/Rx	LINK	Tx	Tx
LED1	LINK100	LINK	LINK	LINK100
LED2	LINK10	FULL	Rx	LINK10
LED3	NA	NA	NA	NA

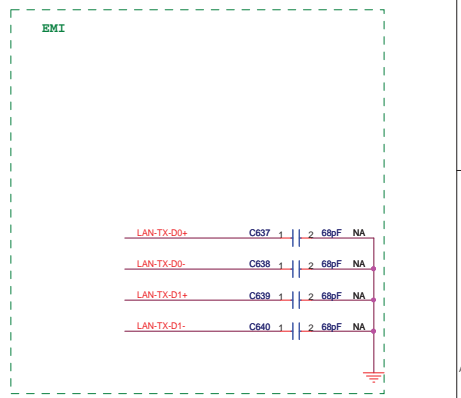
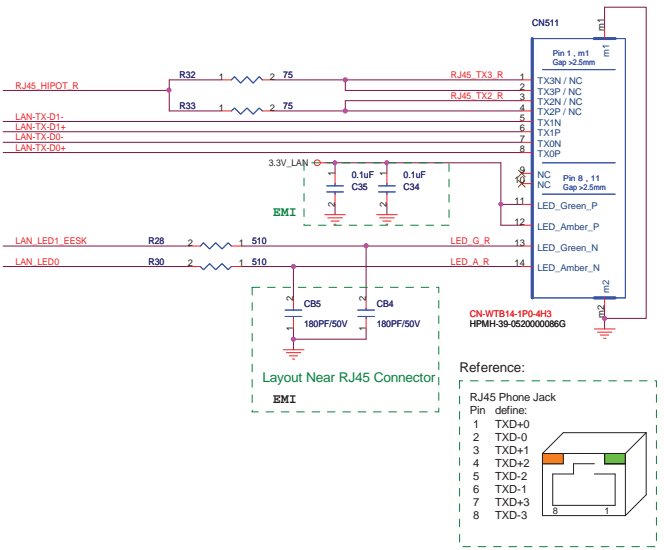
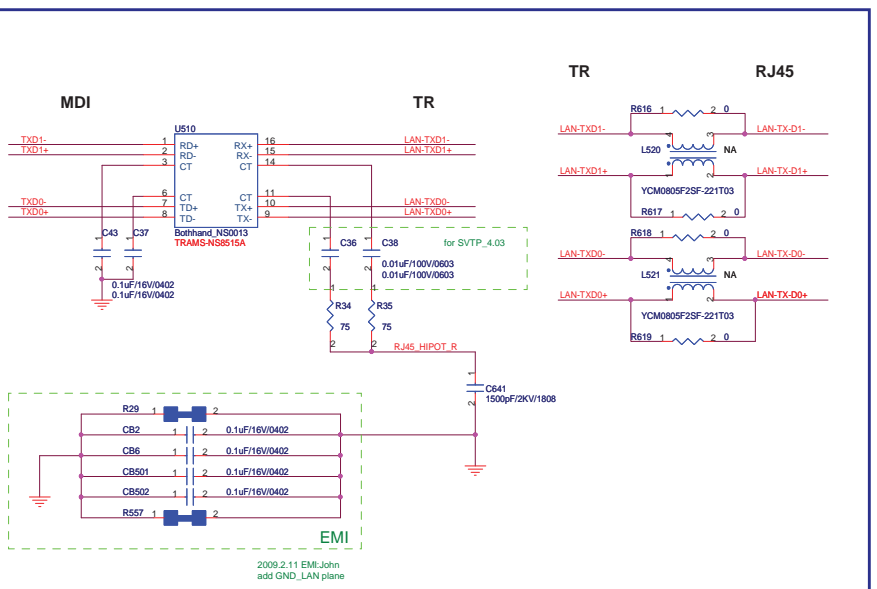
LED S1-0's initial value comes from the 93C46
If there is no 93C46, the default value is 00

H310 mini-spec_v1.4 LAN LED:

- Amber : Activity (RX/TX)
- Green : Connectivity (Link)



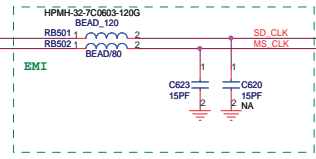
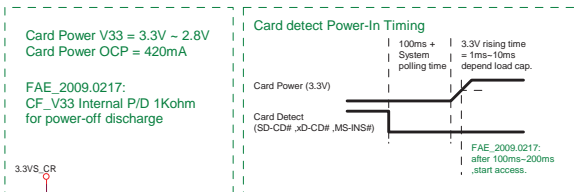
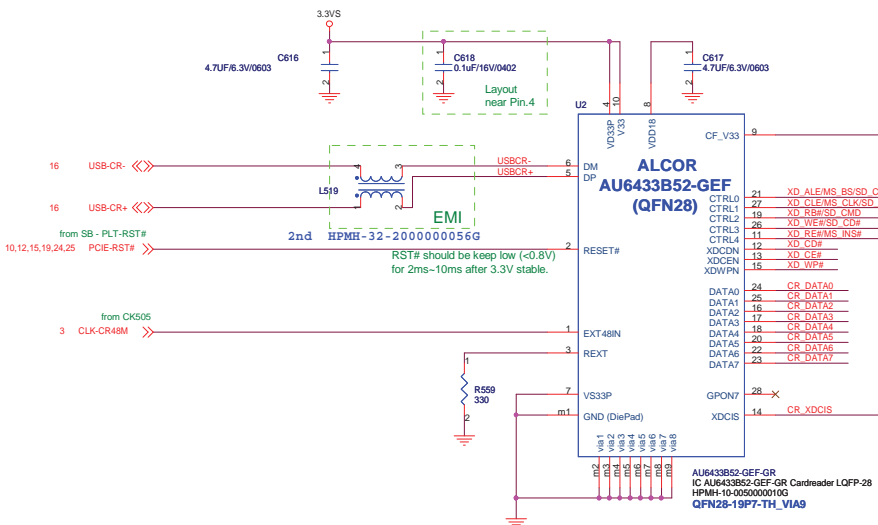
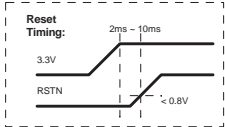
- SVTP_V4.03
2.6 - Ethernet Checklist - Rev C.xls
- Ch.3.1.4.4
Some older cheap RJ-45s only populate pins 1,2,3,6. 10/100 requires the other 4 pins for grounding. Gigabit Ethernet requires all 8 pins for data signals.
 - Ch.3.1.4.13
Resistance from RJ-45 shell to any other chassis ground point (othms) less than 1 ohm
 - Ch.3.1.4.14 & Ch.3.1.4.15
Protection against non-standard power-over-Ethernet (PoE) : Resistance between pins 1,3 (TXD0P, TXD1P) and pins 4,7 (TXD2P, TXD3P) of the RJ-45 greater than 58k ohms.



Card Reader

Alcor AU6433-GEF Card supported:

- SD v2.0 (SDHC)
- MMC v4.2
- MS v1.43
- MS-PRO v1.03
- MS PRO-HG v1.01
- xD v1.2



FAE_2009.0117:
 Memory Stick Formatter for MS Logo Enable

FAE_2009.0117:
 SD write protect
 - Decided by SD-WP of SD Card

XDCIS (Pin.14):
 XD CIS(Card Information Structure) check for xD Logo
 -1: Enable (Internal P/U)
 -0: Disable

Solution for MS Adapter short issue
 when T<128ms,
 XD-CD# event will not be affected.

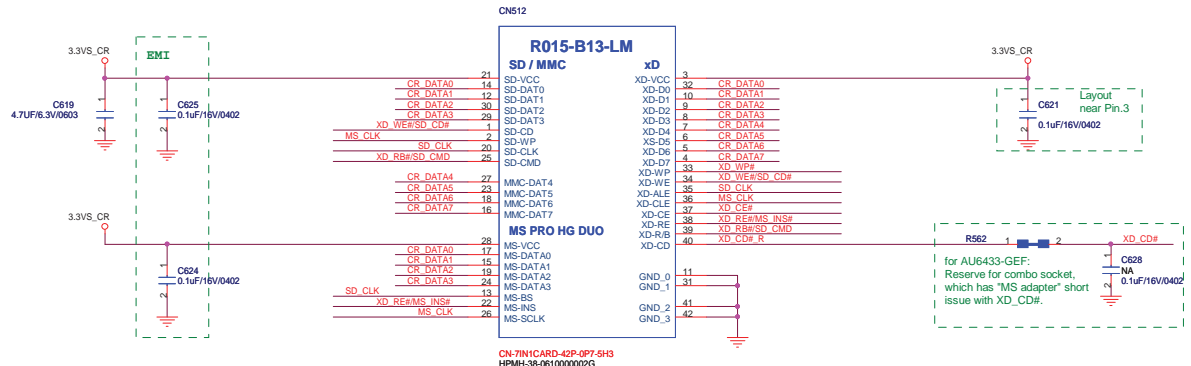
XD-CD# 2V
 MS-INS# 0.8V

AU6433B52-GEF-GR
 IC AU6433B52-GEF-GR Cardreader LQFP-28
 HPMH-10-005000010G
 QFN28-19P7-TH_VIA9

Memory Card Socket

R015-B13-LM
 HPMH-38-061000002G

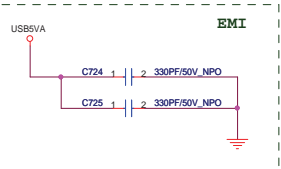
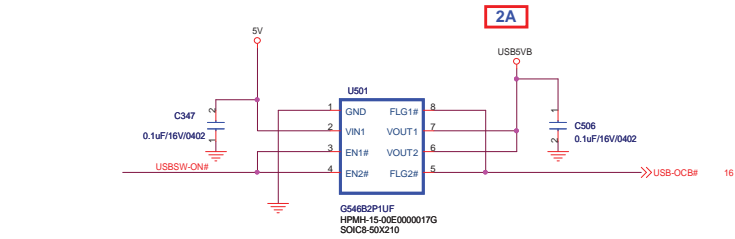
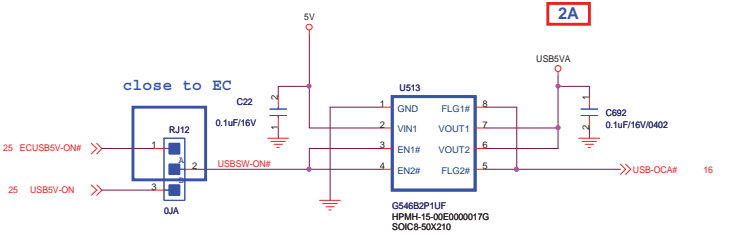
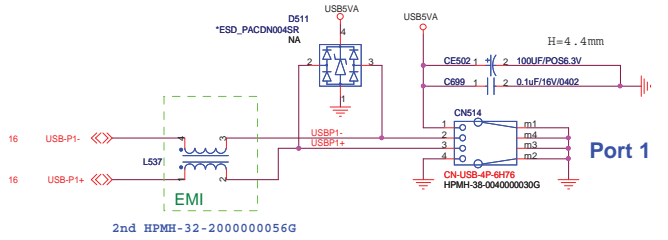
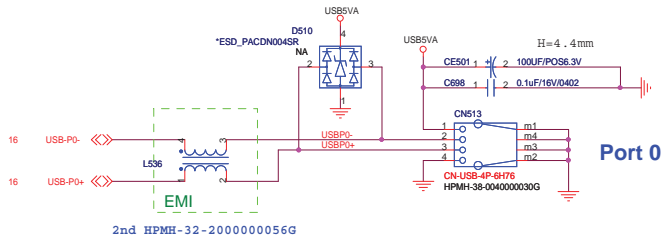
- Card type Supported:
- SD
 - SD IO
 - MMC
 - MMC4.0
 - MS
 - MS Pro
 - xD



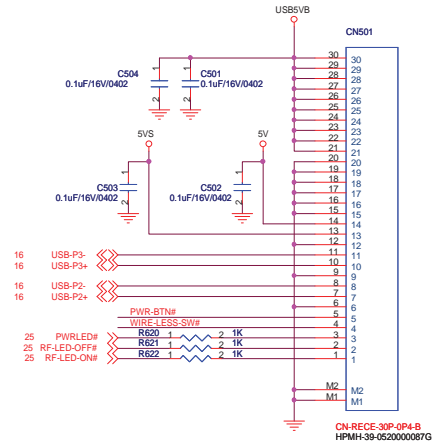
for AU6433-GEF:
 Reserve for combo socket,
 which has "MS adapter" short
 issue with XD_CD#.

CN-71N1CARD-42P-0P7-5H3
 HPMH-38-061000002G

USB Port 0 / 1

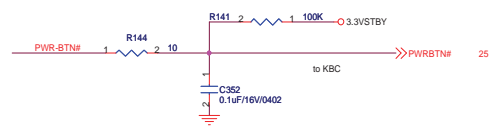


USB DB CONN

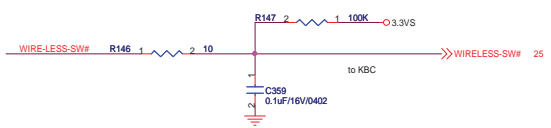


USB Power Connector needs >2A

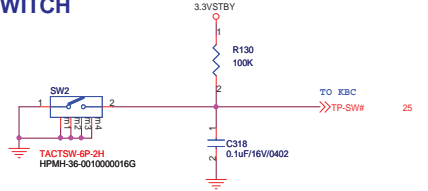
Power ON/OFF Button



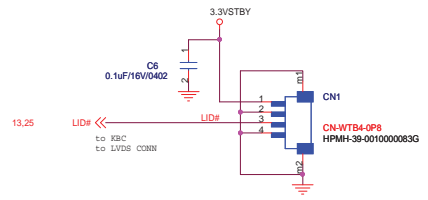
Wireless ON/OFF Button



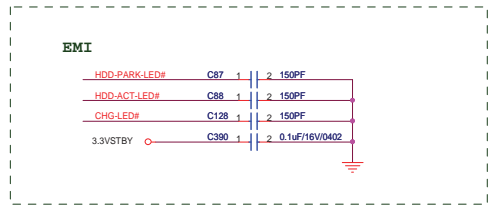
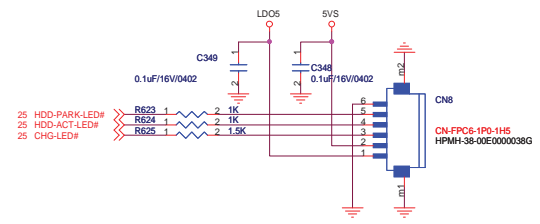
TP LOCK SWITCH



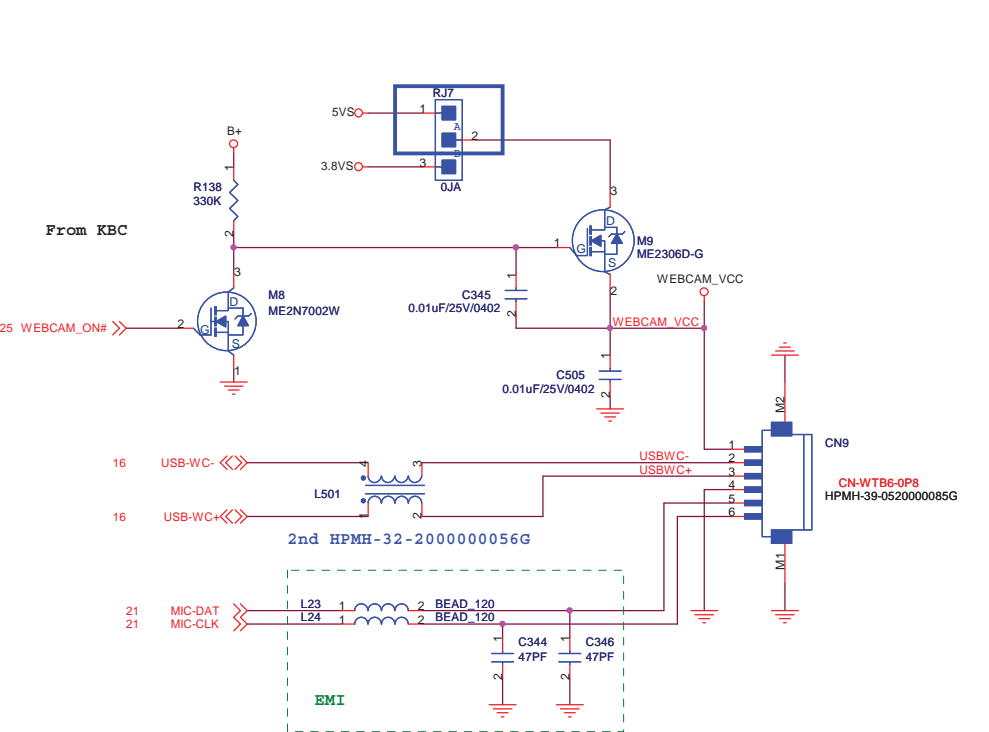
LID Switch



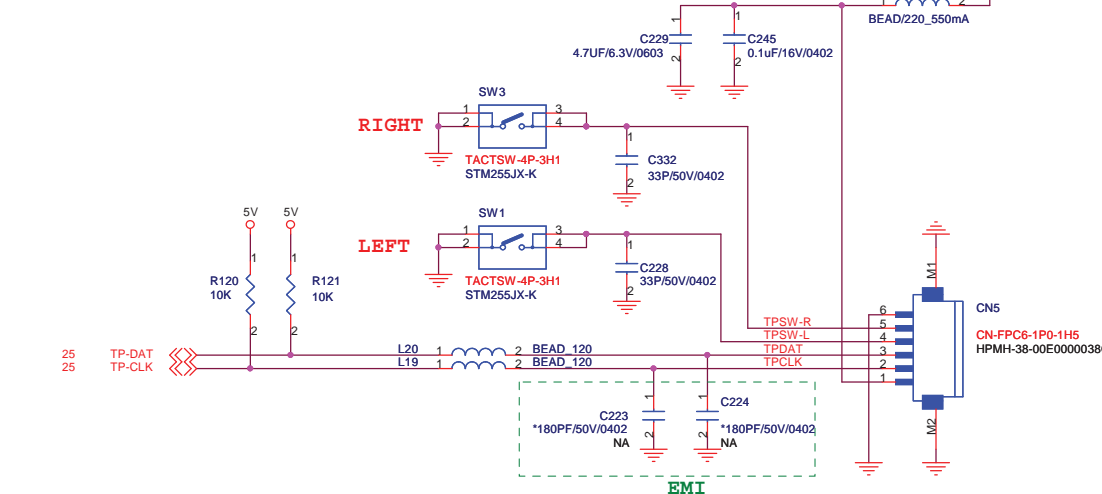
LED DB CONN



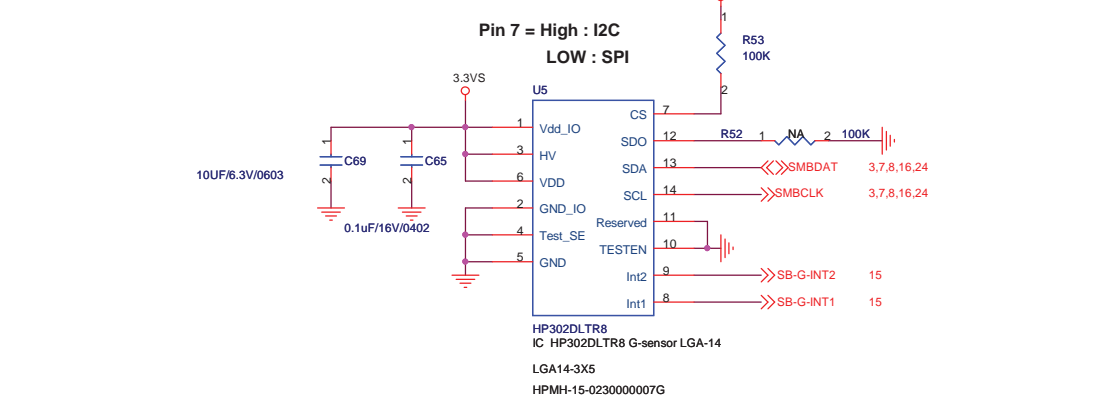
Web CAM



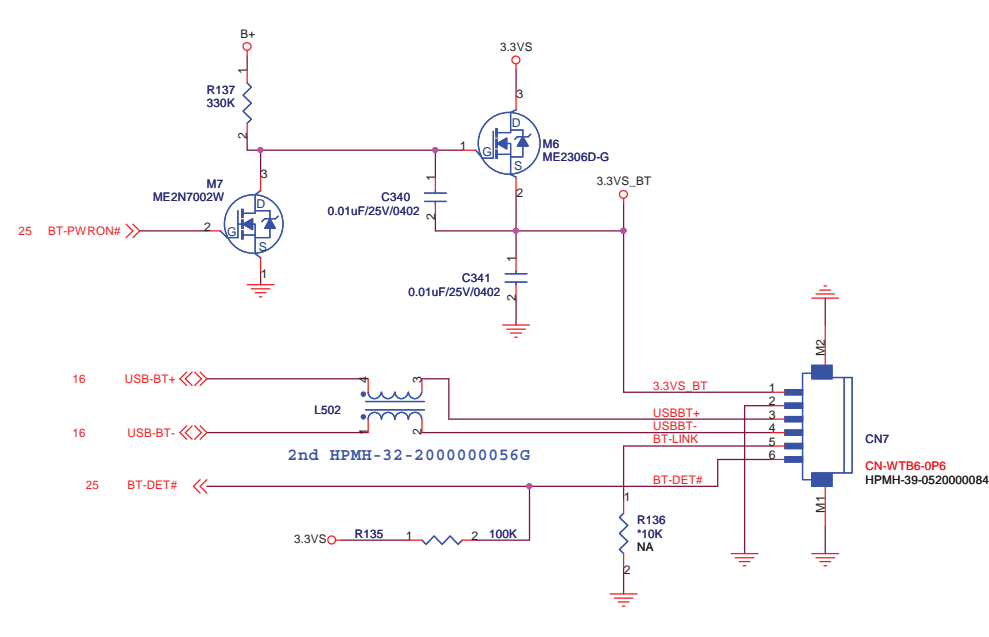
Touch Pad



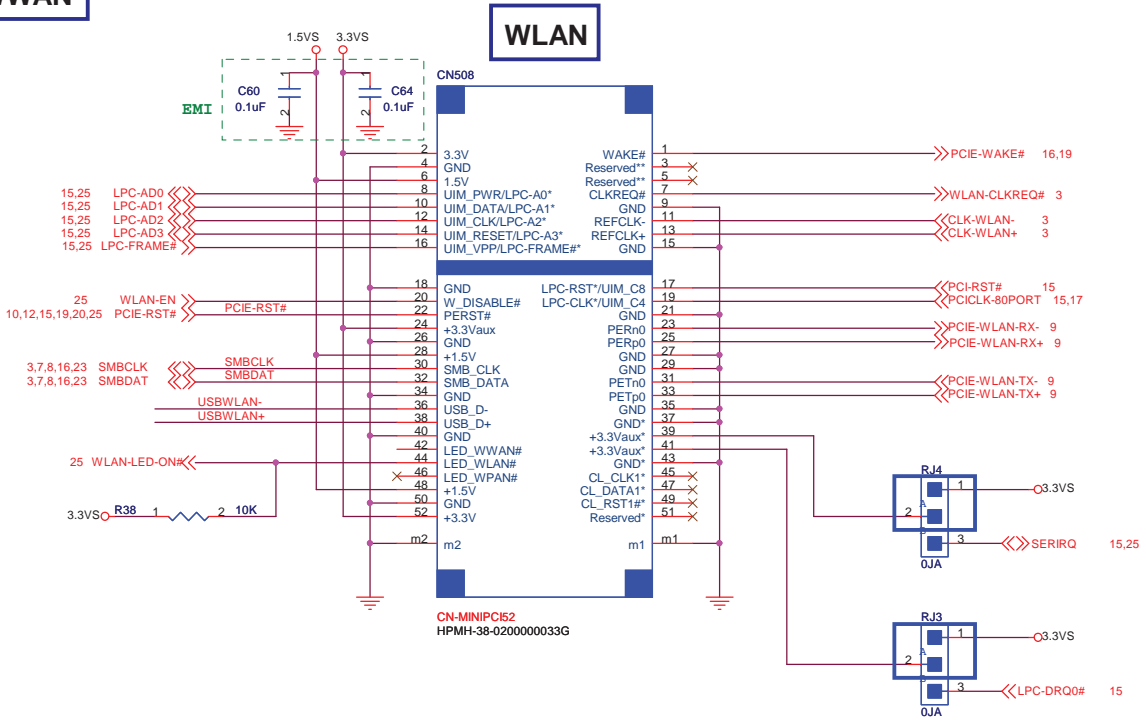
G-Sensor



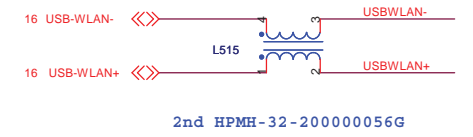
Blue Tooth



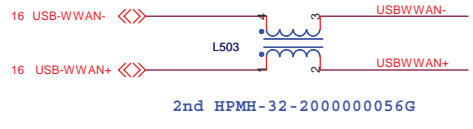
WLAN / WWAN



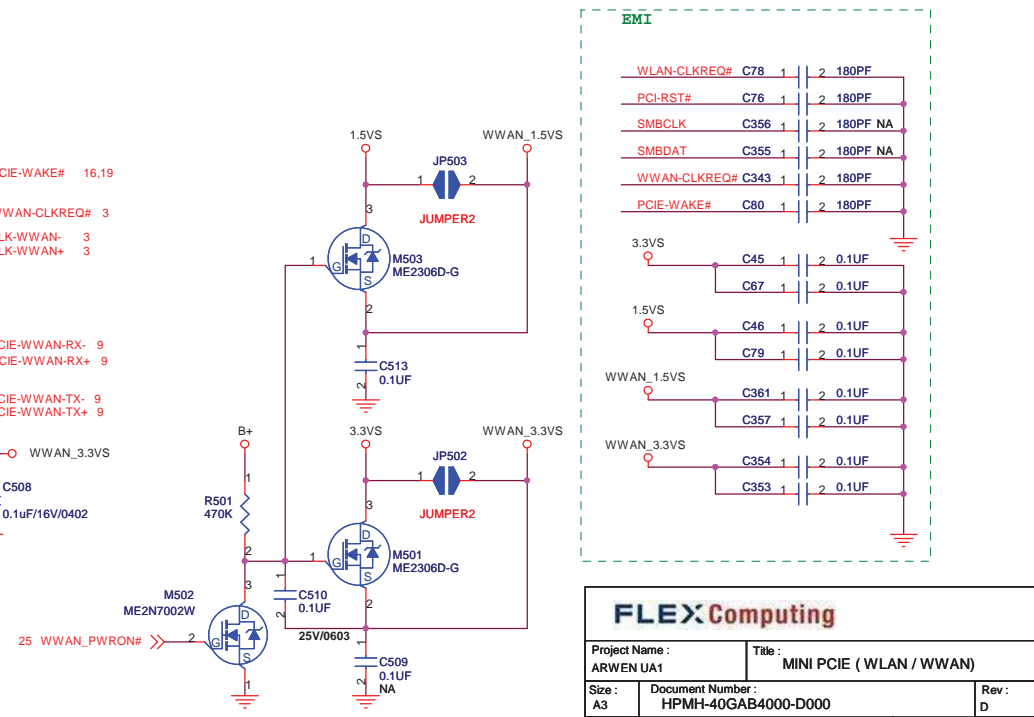
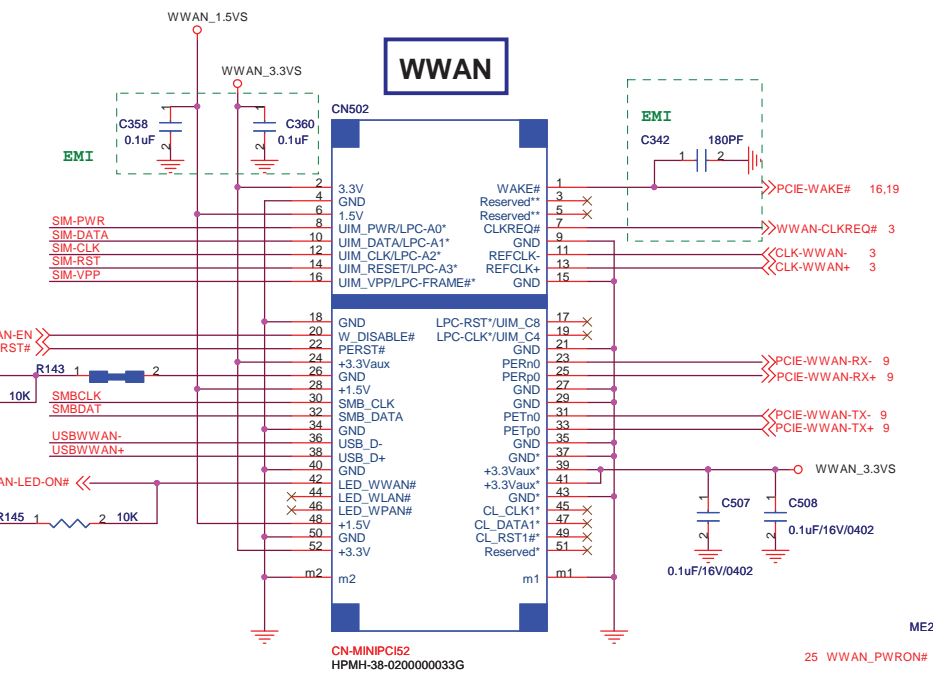
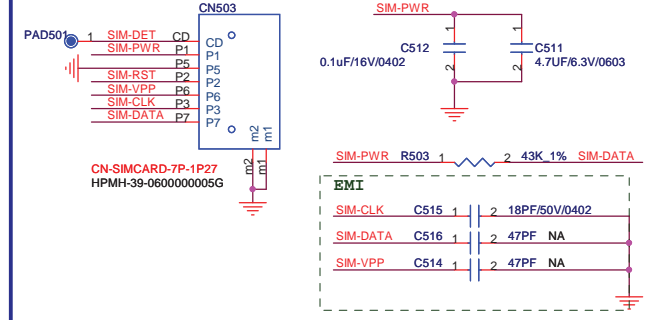
WLAN



WWAN



SIM



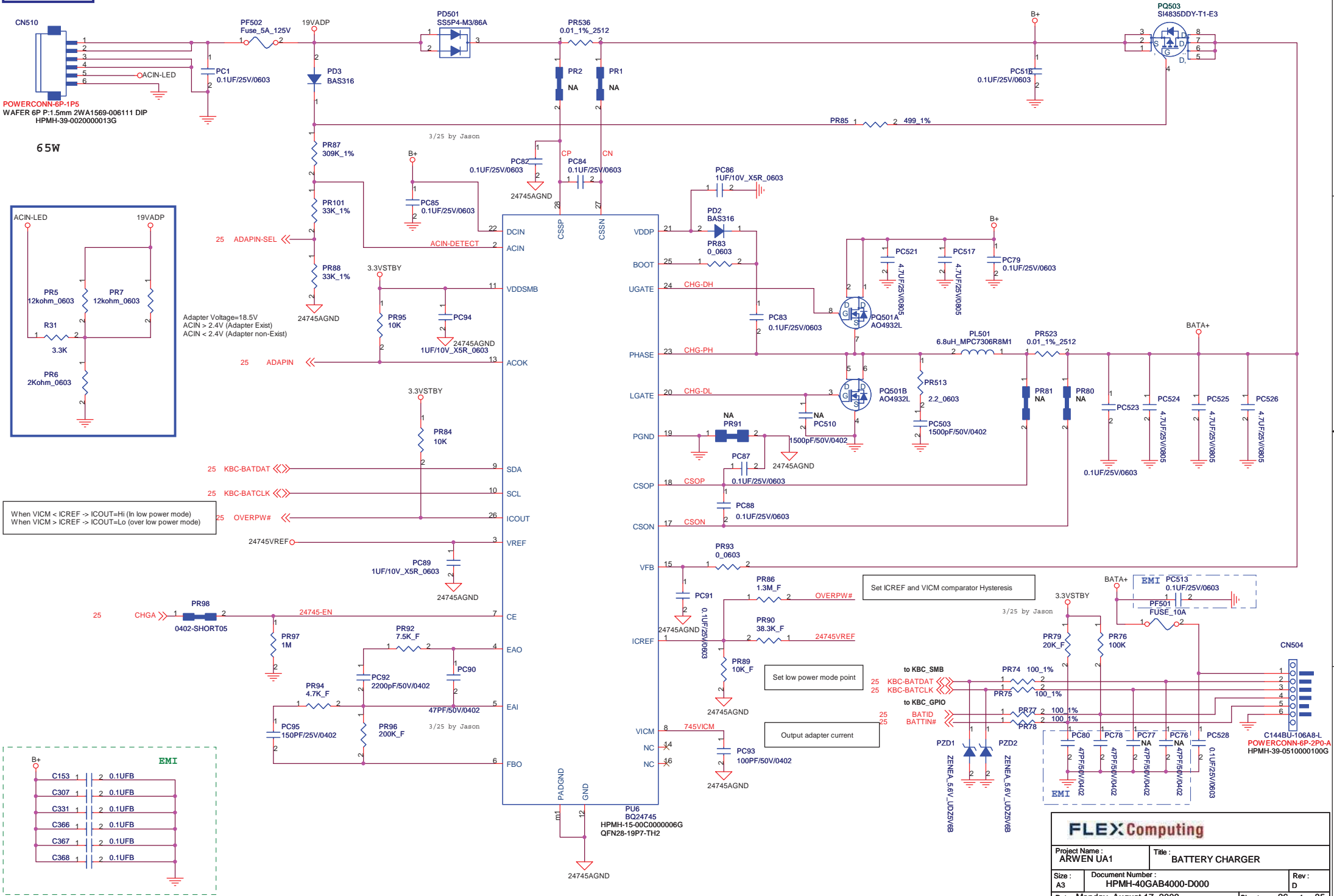
FLEX Computing

Project Name: ARVEN UA1 Title: MINI PCIE (WLAN / WWAN)

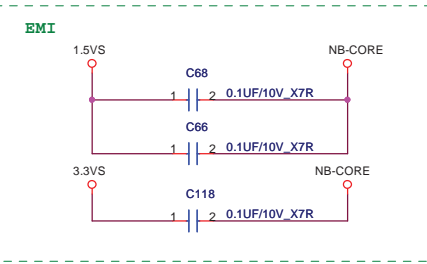
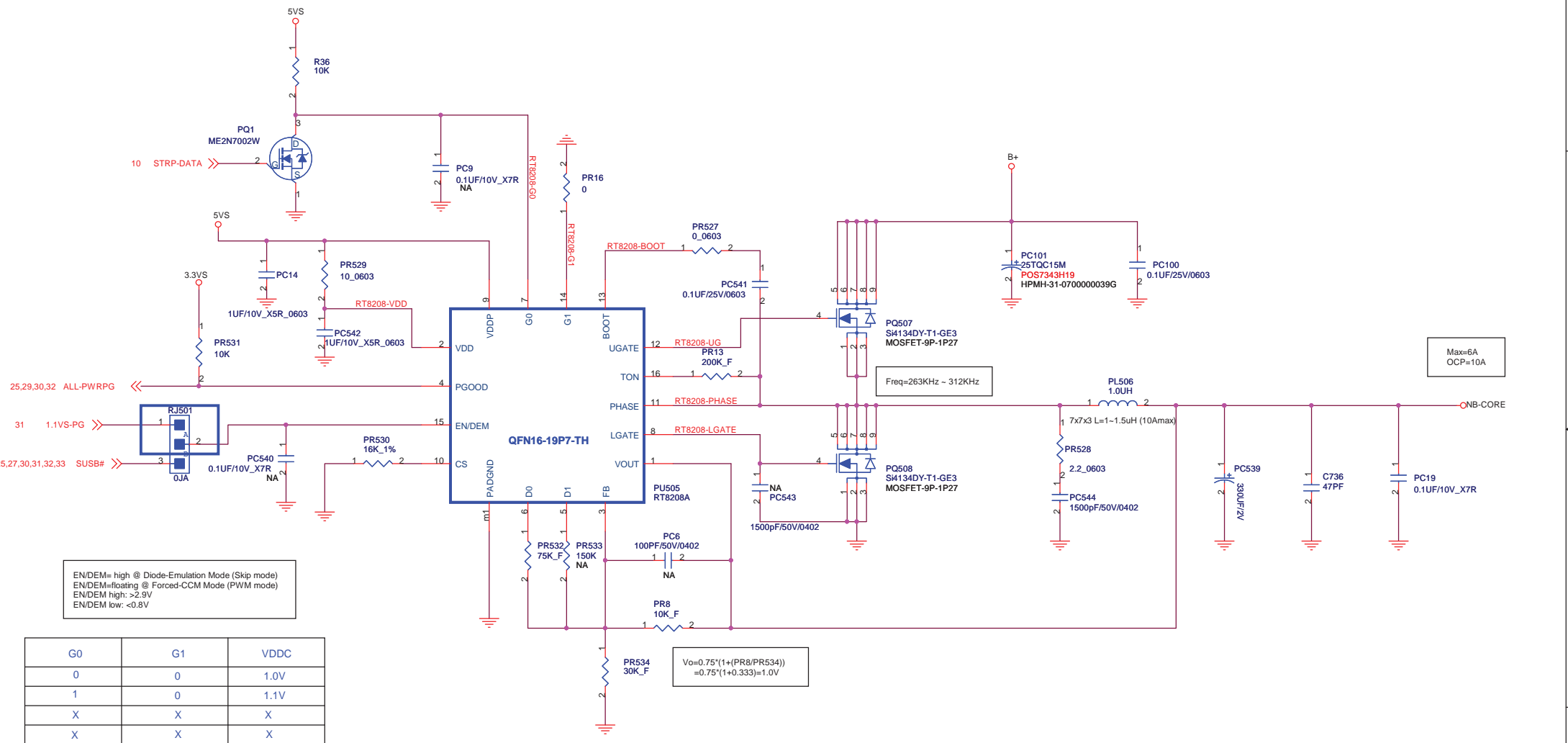
Size: A3 Document Number: HPMH-40GAB4000-D000 Rev: D

Date: Monday, August 17, 2009 Sheet: 24 of 35

Charger



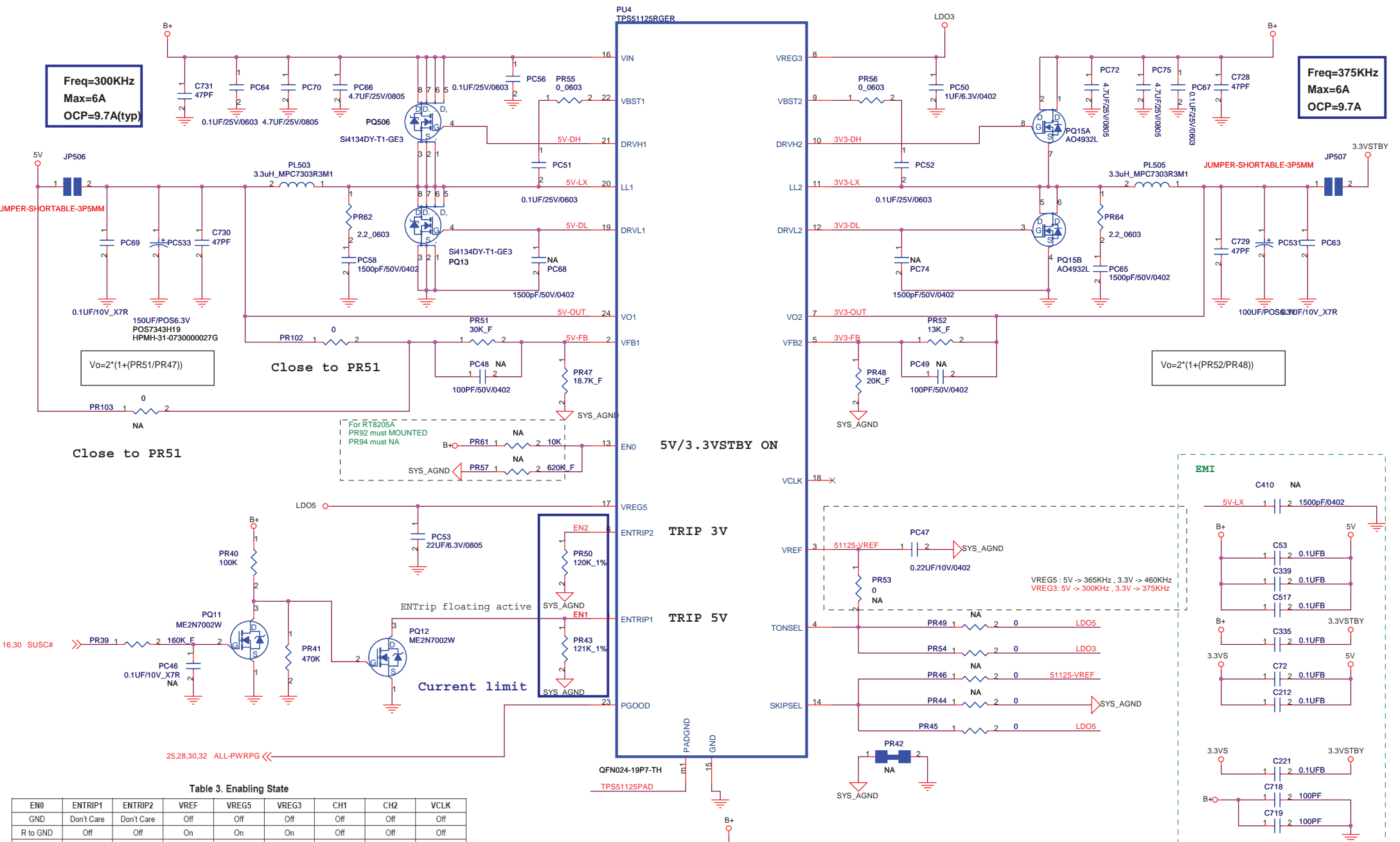
NB_CORE



5V / 3.3VSTBY

Freq=300KHz
Max=6A
OCP=9.7A(typ)

Freq=375KHz
Max=6A
OCP=9.7A



Close to PR51

Close to PR51

$$V_o = 2 * (1 + (PR52 / PR48))$$

5V/3.3VSTBY ON

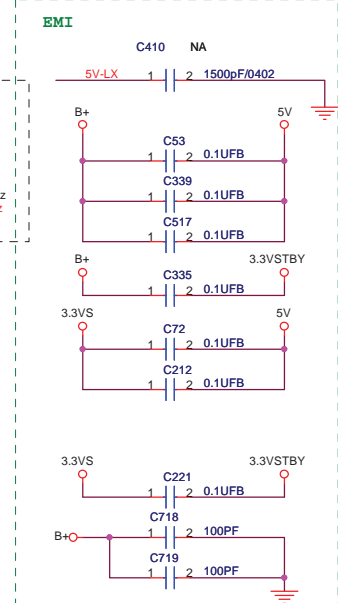
TRIP 3V

TRIP 5V

Current limit

Table 3. Enabling State

EN0	ENTRIP1	ENTRIP2	VREF	VREG5	VREG3	CH1	CH2	VCLK
GND	Don't Care	Don't Care	Off	Off	Off	Off	Off	Off
R to GND	Off	Off	On	On	On	Off	Off	Off
R to GND	On	Off	On	On	On	On	Off	Off
R to GND	Off	On	On	On	On	Off	On	Off
R to GND	On	On	On	On	On	On	On	Off
Open	Off	Off	On	On	On	Off	Off	Off
Open	On	Off	On	On	On	On	Off	On
Open	Off	On	On	On	On	Off	On	Off
Open	On	On	On	On	On	On	On	On



FLEX Computing

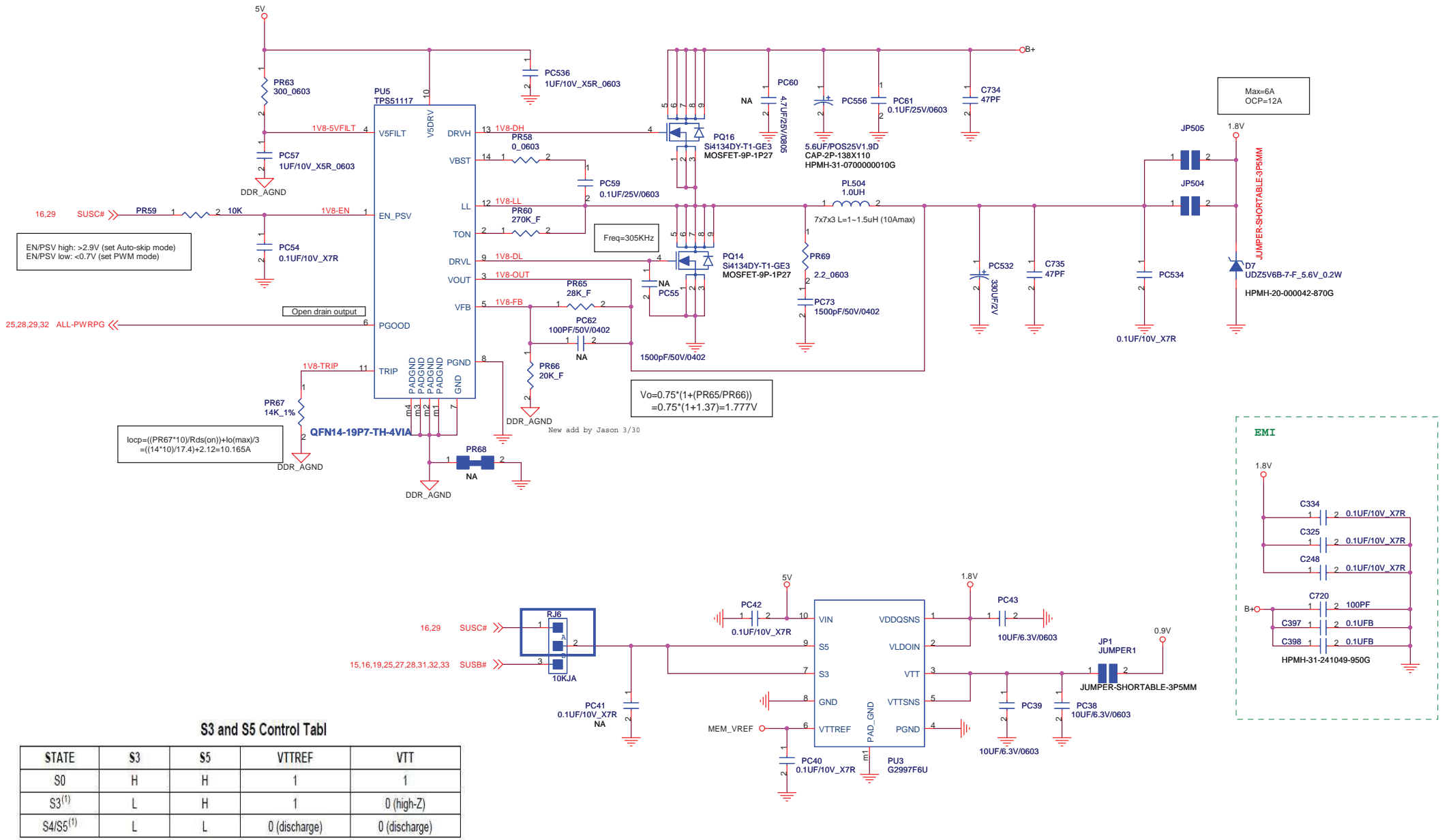
Project Name : ARWEN UA1 Title : 5V/3.3VSTBY

Size : A3 Document Number : HPMH-40GAB4000-D000 Rev : D

Date : Monday, August 17, 2009 Sheet : 29 of 35

For PCB Acoustic Noise

1.8V / 0.9V



EN/PSV high: >2.9V (set Auto-skip mode)
EN/PSV low: <0.7V (set PWM mode)

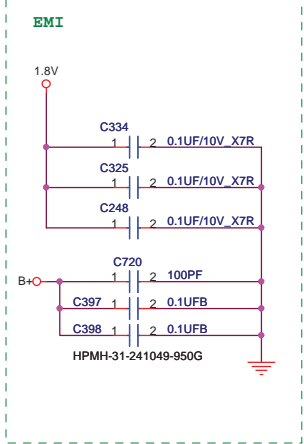
$$V_o = 0.75 \cdot (1 + (PR65/PR66)) = 0.75 \cdot (1 + 1.37) = 1.777V$$

$$loop = ((PR67 \cdot 10) / R_{ds(on)}) + I_o(\max) / 3 = ((14 \cdot 10) / 17.4) + 2.12 = 10.165A$$

S3 and S5 Control Tabl

STATE	S3	S5	VTTREF	VTT
S0	H	H	1	1
S3 ⁽¹⁾	L	H	1	0 (high-Z)
S4/S5 ⁽¹⁾	L	L	0 (discharge)	0 (discharge)

(1) In case S3 is forced to H and S5 to L, VTTREF is discharged and VTT is at High-Z state. This condition is NOT recommended.



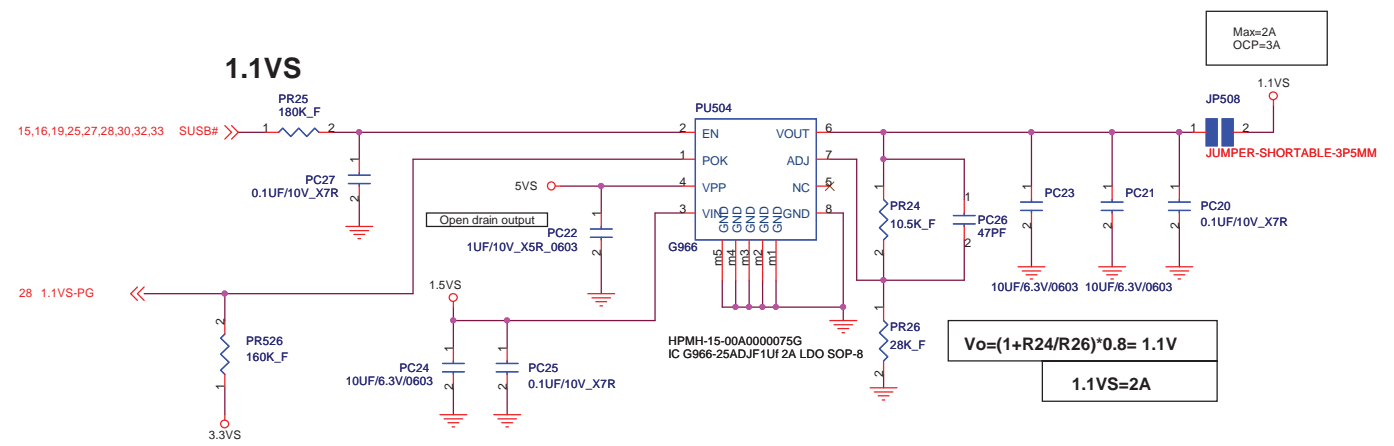
FLEX Computing

Project Name : ARWEN UA1 Title : 1.8V/0.9V

Size : A3 Document Number : HPMH-40GAB4000-D000 Rev : D

Date : Monday, August 17, 2009 Sheet : 30 of 35

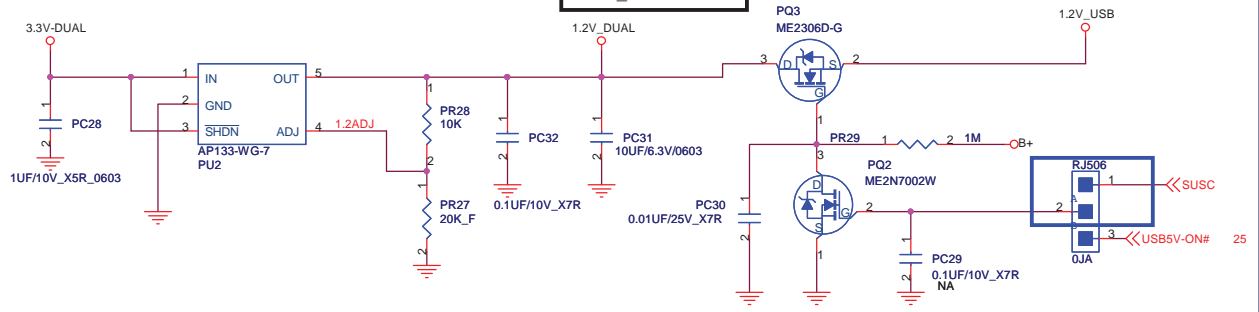
1.1VS



1.2VSTBY / 1.2V_USB

$$V_o = 0.8 * (1 + (PR160 / PR162)) = 0.8 * (1 + 0.5) = 1.2V$$

1.2V_DUAL=250mA

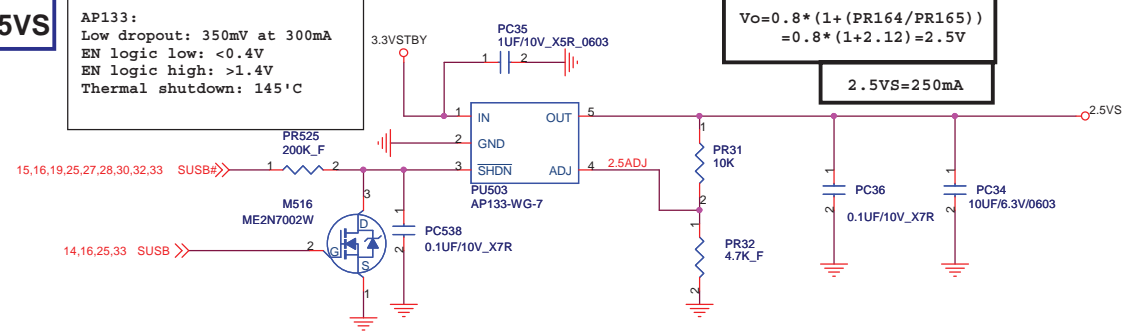


2.5VS

AP133:
 Low dropout: 350mV at 300mA
 EN logic low: <0.4V
 EN logic high: >1.4V
 Thermal shutdown: 145°C

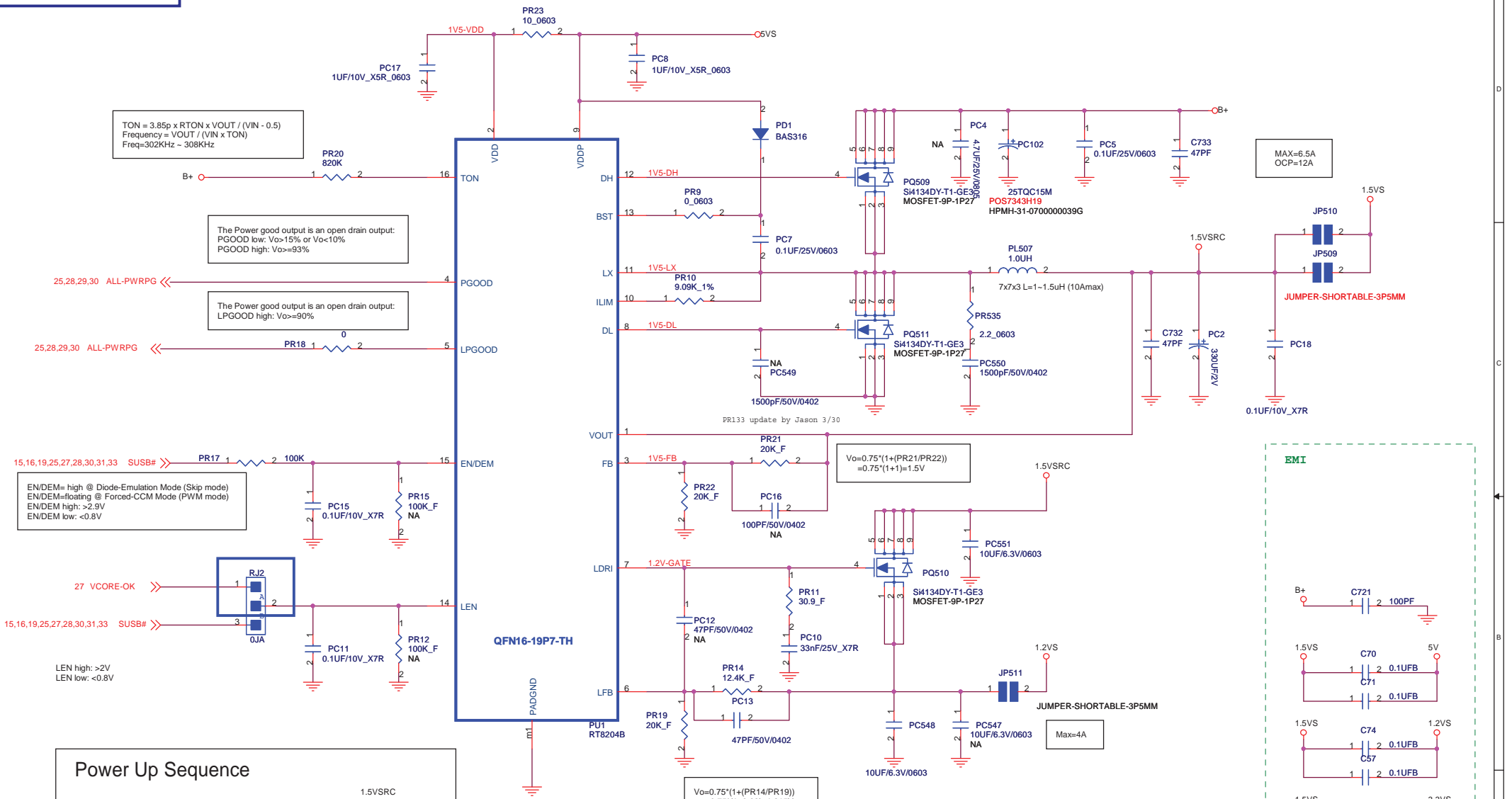
$$V_o = 0.8 * (1 + (PR164 / PR165)) = 0.8 * (1 + 2.12) = 2.5V$$

2.5VS=250mA



FLEX Computing	
Project Name : ARWEN UA1	Title : 1.1VS/2.5VS/1.2V_USB
Size : A3	Document Number : HPMH-40GAB4000-D000
Date: Monday, August 17, 2009	Rev : D
Sheet: 31	of 35

1.5VS / 1.2VS



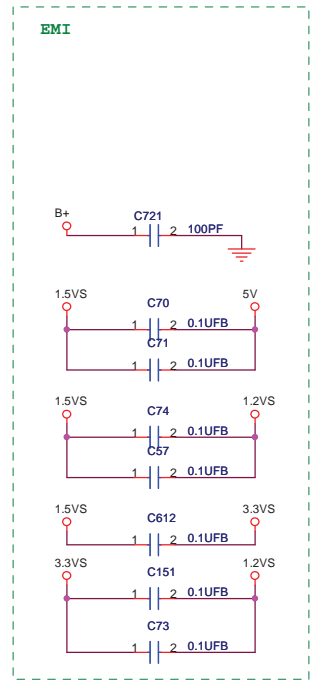
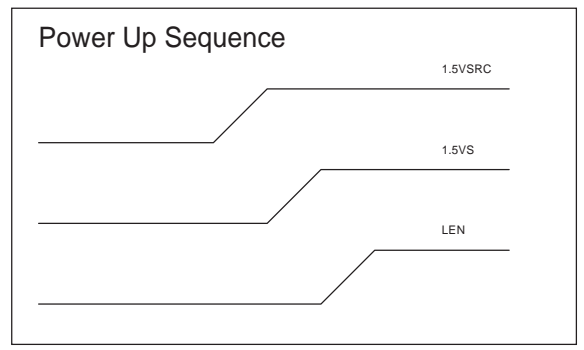
TON = 3.85p x RTON x VOUT / (VIN - 0.5)
 Frequency = VOUT / (VIN x TON)
 Freq=302KHz - 308KHz

The Power good output is an open drain output:
 PGOOD low: Vo>15% or Vo<10%
 PGOOD high: Vo>=93%

The Power good output is an open drain output:
 LPGOOD high: Vo>=90%

EN/DEM= high @ Diode-Emulation Mode (Skip mode)
 EN/DEM=floating @ Forced-CCM Mode (PWM mode)
 EN/DEM high: >2.9V
 EN/DEM low: <0.8V

LEN high: >2V
 LEN low: <0.8V



FLEX Computing	
Project Name: ARWEN UA1	Title: 1.5VS/1.2VS
Size: Custom	Document Number: HPMH-40GAB4000-D000
Date: Monday, August 17, 2009	Rev: D
Sheet: 32 of 35	

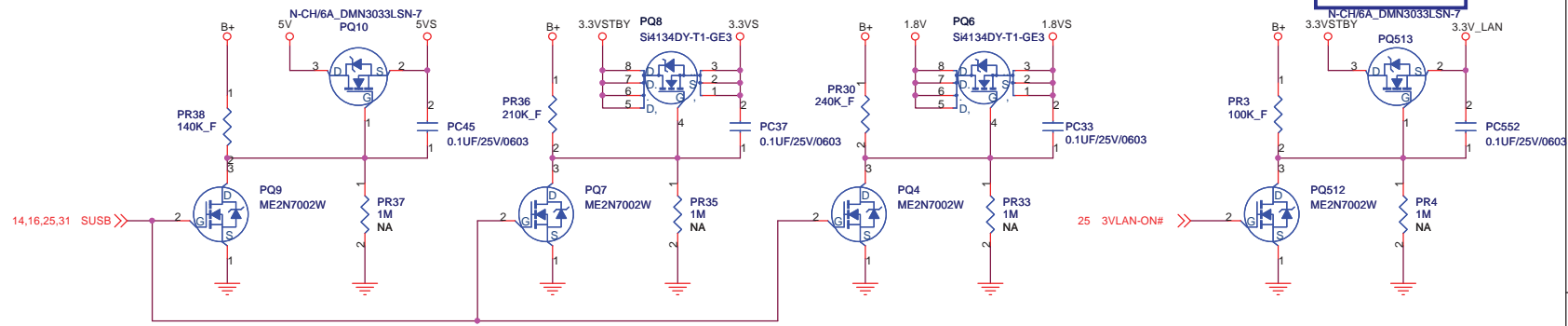
S4/S3 OFF

5VS

3.3VS

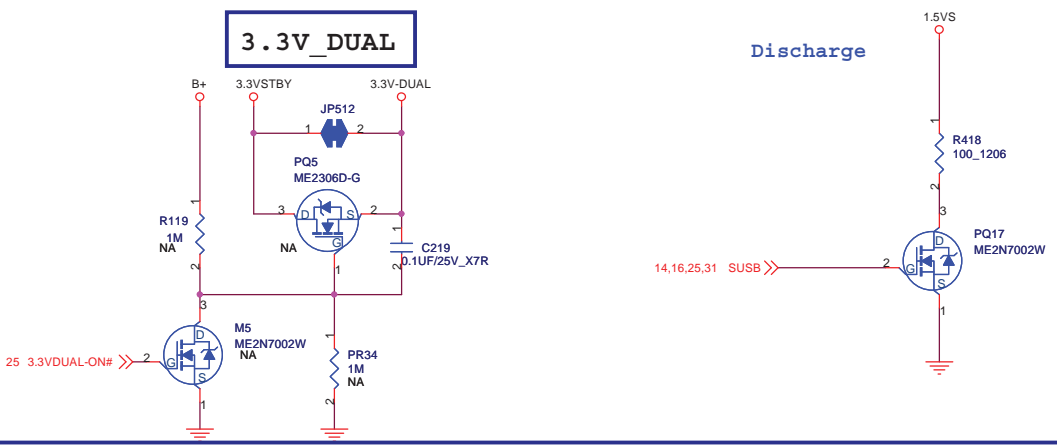
1.8VS

LAN_3.3V



3.3V_DUAL

Discharge



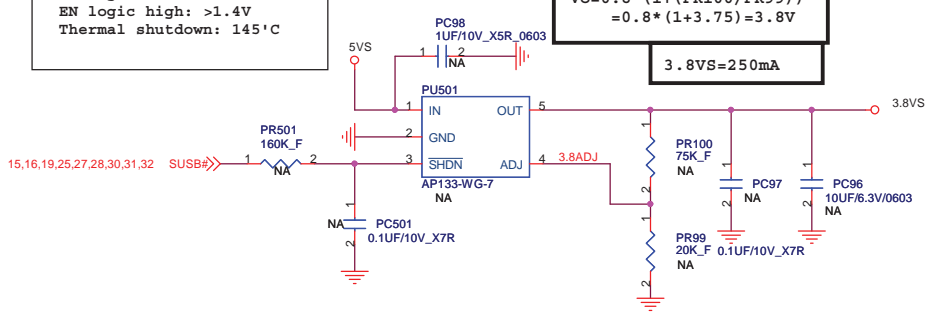
AP133:
 Low dropout: 350mV at 300mA
 EN logic low: <0.4V
 EN logic high: >1.4V
 Thermal shutdown: 145°C

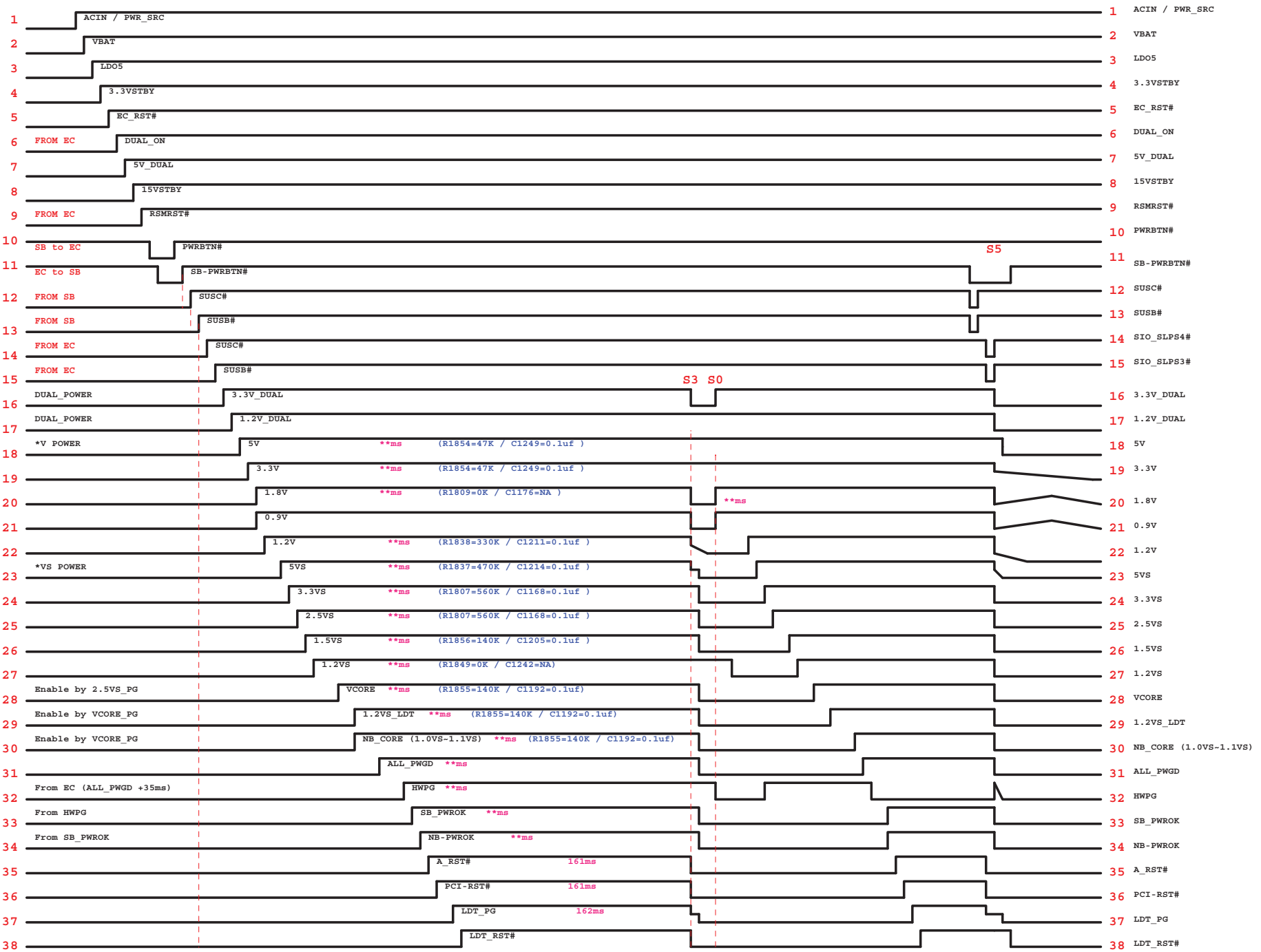
3.8VS

$$V_o = 0.8 * (1 + (PR100 / PR99))$$

$$= 0.8 * (1 + 3.75) = 3.8V$$

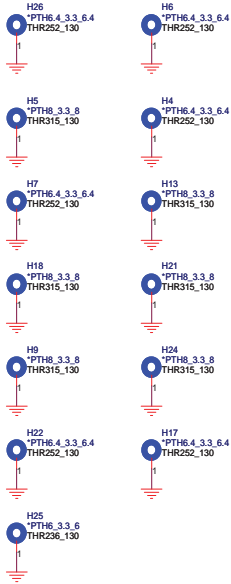
3.8VS=250mA





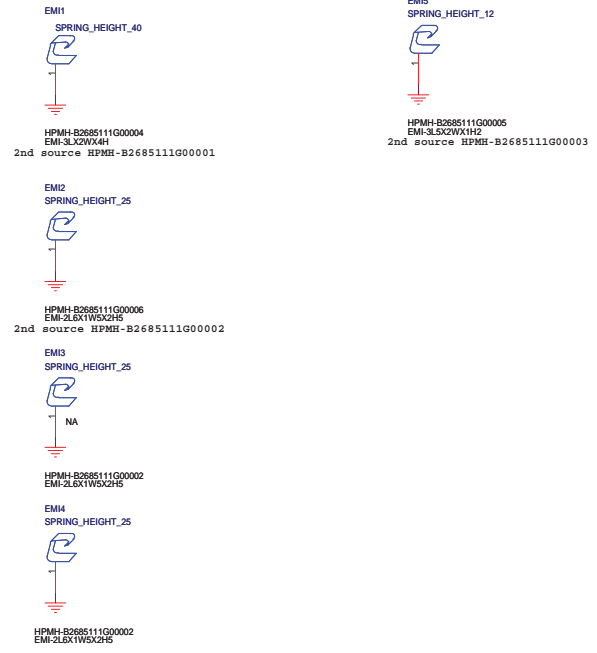
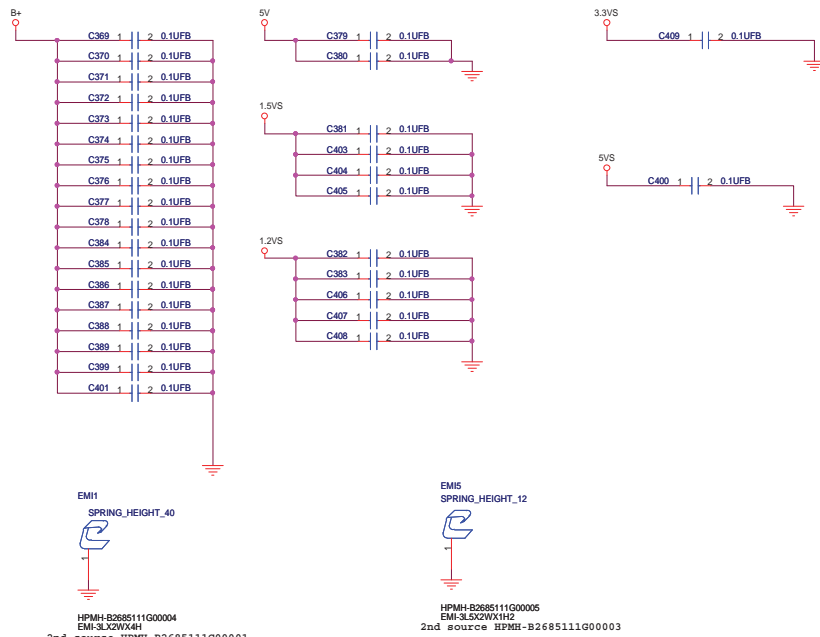
Screw Hole

MB x 16

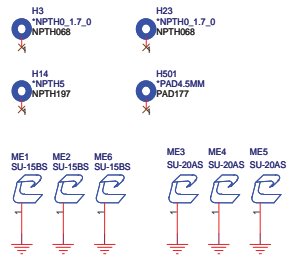
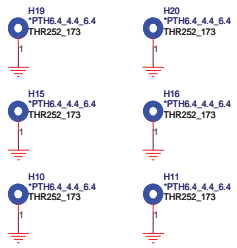


FID

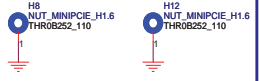
- FID1 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID3 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID4 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID5 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID6 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID7 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID8 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.
- FID2 *FIDUCIAL CAD-016
⊗ NC, NO CONNECT TO ANY.



CPU/VGA x 8



MINI CARD x 2



EMI x 2

